

8-bit Microcontroller

CMOS

F²MC-8L MB89202RA Series

MB89202/F202RA/V201

■ DESCRIPTION

The MB89202RA series is a line of single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers contain a variety of peripheral functions such, timers, a serial interface, an A/D converter and an external interrupt.

Note: F²MC is the abbreviation of FUJITSU Flexible Microcontroller.

■ FEATURES

- F²MC-8L family CPU core
- Maximum memory space : 64 Kbytes
- Minimum execution time : 0.32 μ s/12.5 MHz
- Interrupt processing time : 2.88 μ s/12.5 MHz
- I/O ports : Max 26 channels
- 21-bit time-base timer
- 8-bit PWM timer
- 8/16-bit capture timer/counter
- 10-bit A/D converter : 8 channels
- UART
- 8-bit serial I/O
- External interrupt 1 : Up to 3 channels
- External interrupt 2 : Up to 8 channels
- Wild Register : 2 bytes
- Flash (at least 10,000 program / erase cycles) with read protection

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Be sure to refer to the "Check Sheet" for the latest cautions on development.

"Check Sheet" is seen at the following support page
URL : <http://edevic.fujitsu.com/micom/en-support/>

"Check Sheet" lists the minimal requirement items to be checked to prevent problems beforehand in system development.

MB89202RA Series

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- Low-power consumption modes (sleep mode, and stop mode)
- SH-DIP-32, SSOP-34 package
- CMOS Technology

MB89202RA Series

■ PRODUCT LINEUP

Part number Parameter	MB89202	MB89F202RA	MB89V201
Classification	Mask ROM product	Flash memory product (read protection)	Evaluation product (for development)
ROM size	16 K × 8 bits (internal mask ROM)	16 K × 8 bits (internal flash)	32K x 8 bits (external EPROM)
RAM size	512 × 8 bits		
CPU functions	Number of instructions : 136 Instruction bit length : 8 bits Instruction length : 1 to 3 bytes Data bit length : 1, 8, 16 bits Minimum execution time : 0.32 μs to 5.1 μs (12.5 MHz) Interrupt processing time : 2.88 μs to 46.1 μs (12.5 MHz)		
Ports	General-purpose I/O ports (CMOS) : 26 (also serve as peripherals) (4 ports are also an N-ch open-drain type.)		
21-bit time-base timer	21-bit Interrupt cycle : 0.66 ms, 2.64 ms, 21 ms, or 335.5 ms with 12.5 MHz main clock		
Watchdog timer	Reset generation cycle : 335.5 ms minimum with 12.5 MHz main clock		
8-bit PWM timer	8-bit interval timer operation (square output capable, operating clock cycle : 0.32 μs , 2.56 μs, 5.1 μs, 20.5 μs) 8-bit resolution PWM operation (conversion cycle : 81.9 μs to 21.47 s : in the selection of internal shift clock of 8/16-bit capture timer) Count clock selectable between 8-bit and 16-bit timer/counter outputs		
8/16-bit capture, timer/counter	External captured input selectable 8-bit capture timer/counter × 1 channel + 8-bit timer or 16-bit capture timer/counter × 1 channel Capable of event count operation and square wave output with 8-bit timer 0 or 16-bit counter		
UART	Transfer data length : 6/7/8 bits		
8-bit Serial I/O	8 bits LSB first/MSB first selectable One clock selectable from four operation clocks (one external shift clock, three internal shift clocks : 0.8 μs, 6.4 μs, 25.6 μs)		
12-bit PPG timer	Output frequency : Pulse width and cycle selectable		
External interrupt 1 (wake-up function)	3 independent channels(Interrupt vector, request flag, request output enabled) Rising/falling/both edge selectable Used for wake-up from stop/sleep mode. (Edge detection is also permitted in the stop mode.)		
External interrupt 2 (wake-up function)	8 channels (low-level interrupt only) Used for wake-up from stop/sleep mode. (Edge detection is also permitted in the stop mode.)		

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MB89202RA Series

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Part number Parameter	MB89202	MB89F202RA	MB89V201
10-bit A/D converter	10-bit precision × 8 channels A/D conversion function (Conversion time : 12.16 μs/12.5 MHz) Continuous activation by 8/16-bit timer/counter output or time-base timer counter		
Wild Register	8-bit × 2		
Standby mode	Sleep mode, and Stop mode		
Overhead time from reset to the first instruction execution	Power-on reset : Oscillation stabilization wait*1 External reset : a few μs Software reset : a few μs	Power-on reset : Voltage regulator and oscillation stabilization wait (31.5 ms/12.5 MHz) External reset : Oscillation stabilization wait (21.0 ms/12.5 MHz) Software reset : a few μs	Power-on reset : Oscillation stabilization wait (21.0 ms / 12.5 MHz) External reset : Oscillation stabilization wait (21.0 ms / 12.5 MHz) Software reset : a few μs
Power supply voltage*2	2.2 V to 5.5 V	3.5 V to 5.5 V	2.7 V to 5.5 V

*1 : Check section “■ MASK OPTIONS”

*2 : The minimum operating voltage varies with the operating frequency, the function. (The operating voltage of the A/D converter is assured separately. Check section “■ ELECTRICAL CHARACTERISTICS.”)

■ PACKAGE AND CORRESPONDING PRODUCTS

Package	MB89202	MB89F202RA	MB89V201
DIP-32P-M06	○	○	×
FPT-34P-M03	○	○	×
FPT-64P-M03	×	×	○

○ : Available × : Not available

■ DIFFERENCES AMONG PRODUCTS

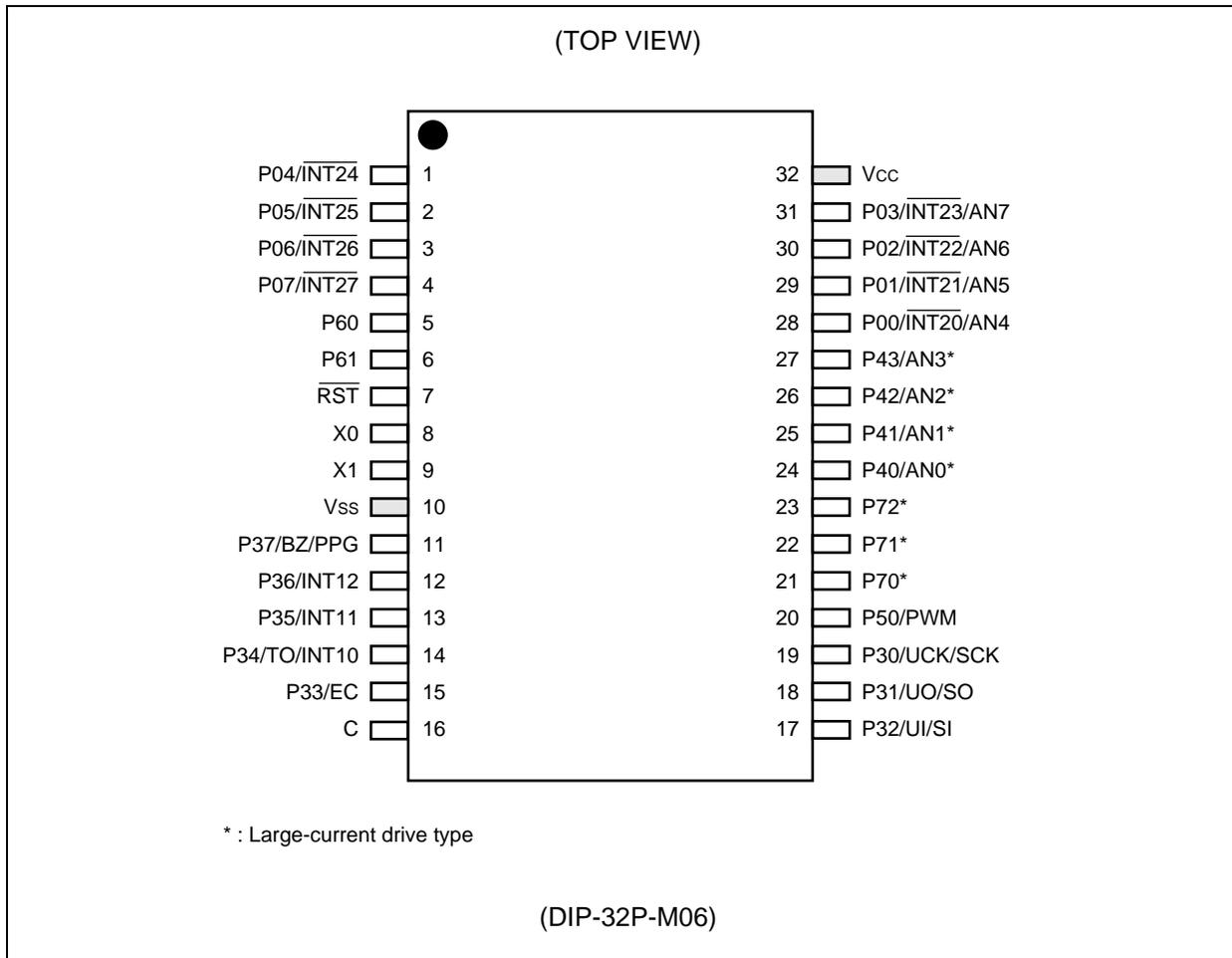
• Memory Size

Before evaluating using the evaluation product, verify its differences from the product that will actually be used.

• Mask Options

Functions that can be selected as options and how to designate these options vary by the product. Before using options check section “■ MASK OPTIONS”.

■ PIN ASSIGNMENTS

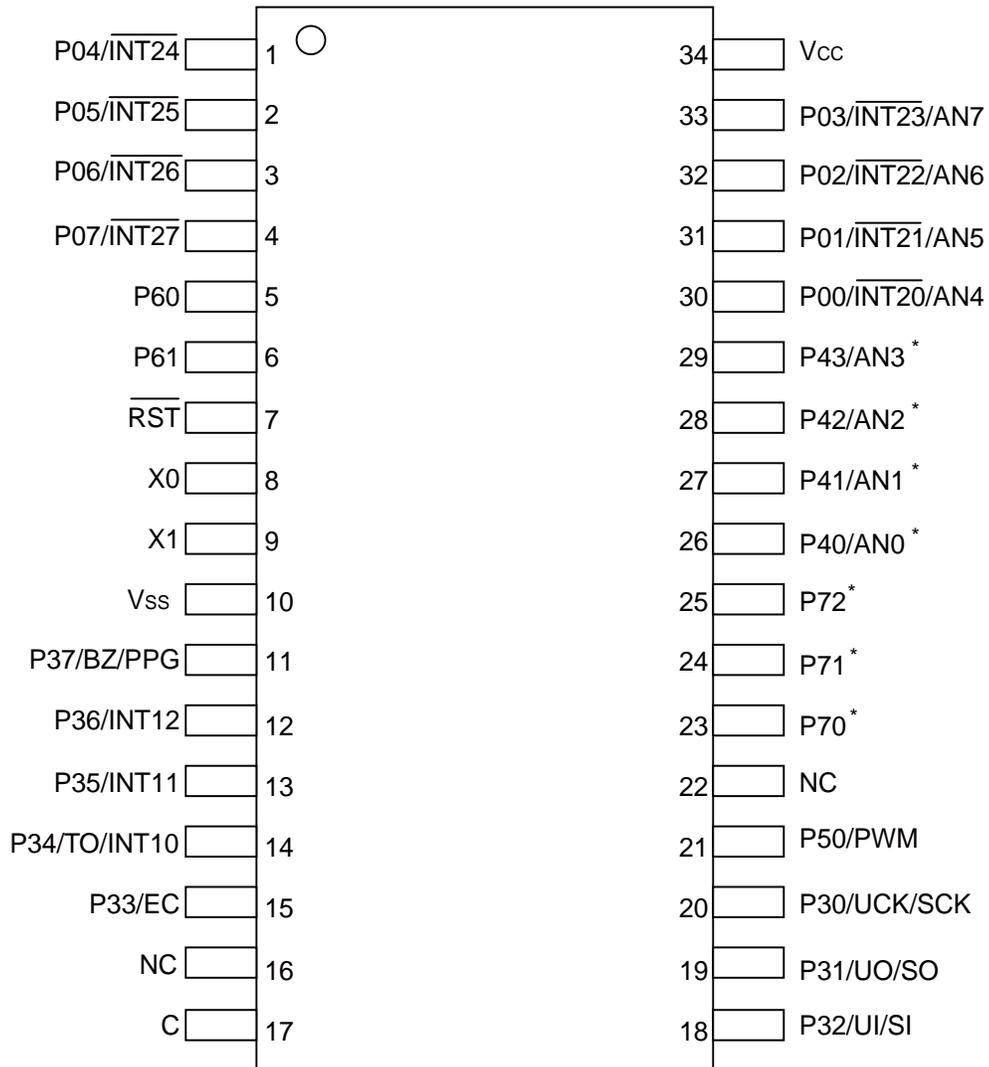


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MB89202RA Series

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(TOP VIEW)



* : Large-current drive type

NC: Internally connected. Do not use.

(FPT-34P-M03)

MB89202RA Series

■ PIN DESCRIPTION

Pin No.		Pin name	I/O circuit type*3	Function
SH-DIP32*1	SSOP34*2			
8	8	X0	A	Pins for connecting the crystal for the main clock. To use an external clock, input the signal to X0 and leave X1 open.
9	9	X1		
5, 6	5, 6	P60, P61	H / E	General-purpose CMOS input ports for MB89F202RA. General-purpose CMOS I/O ports for MB89202/MB89V201.
7	7	$\overline{\text{RST}}$	C	Reset I/O pin. This pin serves as an N-channel open-drain reset output and a reset input as well. The reset is a hysteresis input. It outputs the “L” signal in response to an internal reset request. Also, it initializes the internal circuit upon input of the “L” signal.
1 to 4	1 to 4	P04/ $\overline{\text{INT24}}$ to P07/ $\overline{\text{INT27}}$	D	General-purpose CMOS I/O ports. These pins also serve as an input (wake-up input) of external interrupt 2. The input of external interrupt 2 is a hysteresis input.
28, 29	30, 31	P00/ $\overline{\text{INT20}}$ / AN4 , P01/ $\overline{\text{INT21}}$ / AN5	G	General-purpose CMOS I/O ports. These pins also serve as an input (wake-up input) of external interrupt 2 or as a 10-bit A/D converter analog input. The input of external interrupt 2 is a hysteresis input.
30, 31	32, 33	P02/ $\overline{\text{INT22}}$ / AN6, P03/ $\overline{\text{INT23}}$ / AN7	G	General-purpose CMOS I/O ports. These pins also serve as an input (wake-up input) of external interrupt 2 or as a 10-bit A/D converter analog input. The input of external interrupt 2 is a hysteresis input.
19	20	P30/U $\overline{\text{CK}}$ / S $\overline{\text{CK}}$	B	General-purpose CMOS I/O port. This pin also serves as the clock I/O pin for the UART or 8-bit serial I/O. The resource is a hysteresis input.
18	19	P31/U $\overline{\text{O}}$ /SO	E	General-purpose CMOS I/O port. This pin also serves as the data output pin for the UART or 8-bit serial I/O.
17	18	P32/U $\overline{\text{I}}$ /SI	B	General-purpose CMOS I/O port. This pin also serves as the data input pin for the UART or 8-bit serial I/O. The resource is a hysteresis input.
15	15	P33/EC	B	General-purpose CMOS I/O port. This pin also serves as the external clock input pin for the 8/16-bit capture timer/counter. The resource is a hysteresis input.
14	14	P34/T $\overline{\text{O}}$ / INT10	B	General-purpose CMOS I/O port. This pin also serves as the output pin for the 8/16-bit capture timer/counter or as the input (wake-up input) for external interrupt 1. The resource is a hysteresis input.
13, 12	13, 12	P35/INT11, P36/INT12	B	General-purpose CMOS I/O ports. These pins also serve as the input (wake-up input) for external interrupt 1. The resource is a hysteresis input.

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MB89202RA Series

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Pin No.		Pin name	I/O circuit type ^{*3}	Function
SH-DIP32 ^{*1}	SSOP34 ^{*2}			
11	11	P37/BZ/ PPG	E	General-purpose CMOS I/O port. This pin also serves as the buzzer output pin or the 12-bit PPG output.
20	21	P50/PWM	E	General-purpose CMOS I/O port. This pin also serves as the 8-bit PWM timer output pin.
24 to 27	26 to 29	P40/AN0 to P43/AN3	F	General-purpose CMOS I/O ports. These pins can also be used as N-channel open-drain ports. These pins also serve as 10-bit A/D converter analog input pins.
21 to 23	23 to 25	P70 to P72	E	General-purpose CMOS I/O ports.
32	34	V _{CC}	—	Power supply pin
10	10	V _{SS}	—	Power (GND) pin
16	17	C	—	MB89F202RA: Capacitance pin for regulating the power supply. Connect an external ceramic capacitor of about 0.1μF. MB89202: This pin is not internally connected. It is unnecessary to connect a capacitor.
—	16, 22	NC	—	Internally connected pins Be sure to leave it open.

*1: DIP-32P-M06

*2: FPT-34P-M03

*3: Refer to "■ I/O CIRCUIT TYPE" for details on the I/O circuit types.

I/O CIRCUIT TYPE

Type	Circuit	Remarks
A	<p>Standby control signal</p>	At an oscillation feedback resistance of approximately 500 kΩ
B	<p>Input enable</p> <p>Port input / Resource input</p>	<ul style="list-style-type: none"> • CMOS output • Hysteresis input • Pull-up resistor optional
C	<p>P-ch (not available for MB89F202RA)</p> <p>N-ch</p> <p>Reset</p>	<ul style="list-style-type: none"> • At an output pull-up resistor (P-ch) of approximately 50 kΩ/5.0 V (not available for MB89F202RA) • N-ch open-drain reset output • Hysteresis input • High voltage input tolerable in MB89F202RA
D	<p>Input enable</p> <p>Input enable</p> <p>Port input</p> <p>Resource input</p>	<ul style="list-style-type: none"> • CMOS output • CMOS input • Hysteresis input (Resource input) • Pull-up resistor optional

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MB89202RA Series

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Type	Circuit	Remarks
E		<ul style="list-style-type: none"> • CMOS output • CMOS input • Pull-up resistor optional • P70-P72 are large-current drive type
F		<ul style="list-style-type: none"> • CMOS output • CMOS input • Analog input • N-ch open-drain output available • P40-P43 are large-current drive type
G		<ul style="list-style-type: none"> • CMOS output • CMOS input • Hysteresis input (Resource input) • Analog input
H		<p>CMOS input</p>

■ HANDLING DEVICES

• Preventing Latchup

Latchup may occur on CMOS ICs if voltage higher than V_{CC} or lower than V_{SS} is applied to input and output pins other than medium- and high-voltage pins or if higher than the voltage which shows on “1. Absolute Maximum Ratings” in section “■ ELECTRICAL CHARACTERISTICS” is applied between V_{CC} and V_{SS} .

When latchup occurs, power supply current increases rapidly and might thermally damage elements. When using, take great care not to exceed the absolute maximum ratings.

• Treatment of Unused Input Pins

Leaving unused input terminals open may lead to permanent damage due to malfunction and latchup; pull up or pull down the terminals through the resistors of 2 k Ω or more.

Make the unused I/O terminal in a state of output and leave it open or if it is in an input state, handle it with the same procedure as the input terminals.

• Treatment of NC Pins

Be sure to leave (internally connected) NC pins open.

• Power Supply Voltage Fluctuations

Although V_{CC} power supply voltage is assured to operate within the rated range, a rapid fluctuation of the voltage could cause malfunctions, even if it occurs within the rated range. Stabilizing voltage supplied to the IC is therefore important. As stabilization guidelines, it is recommended to control power so that V_{CC} ripple fluctuations (P-P value) will be less than 10% of the standard V_{CC} value at the commercial frequency (50 Hz/60 Hz) and the transient fluctuation rate will be less than 0.1 V/ms at the time of a momentary fluctuation such as when power is switched.

• Precautions when Using an External Clock

When an external clock is used, oscillation stabilization time is required even for power-on reset (optional) and wake-up from stop mode.

• About the Wild Register Function

No wild register can be debugged on the MB89V201. For the operation check, test the MB89F202RA installed on a target system.

• Program Execution in RAM

When the MB89V201 is used, no program can be executed in RAM.

• Note to Noise in the External Reset Pin (\overline{RST})

If the reset pulse applied to the external reset pin (\overline{RST}) does not meet the specifications, it may cause malfunctions. Use caution so that the reset pulse less than the specifications will not be fed to the external reset pin (\overline{RST}).

• External pullup for the External Reset Pin (\overline{RST})

Internal pullup control for \overline{RST} pin is not available for MB89F202RA. To ensure proper external reset control in MB89F202RA, an external pullup (recommend 100 k Ω) for \overline{RST} pin must be required. Please also check section “■ PROGRAMMING AND ERASE FLASH MEMORY”.

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MB89202RA Series

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- **Notes on selecting mask option**

Please select "With reset output" by the mask option when power-on reset is generated at the power supply ON, and the device is used without inputting external reset.

■ PROGRAMMING AND ERASE FLASH MEMORY

1. Flash Memory

The flash memory incorporates a flash memory interface circuit that allows read access and program access from the CPU to be performed in the same way as mask ROM. Programming and erasing flash memory is also performed via the flash memory interface circuit by executing instructions in the CPU. This enables the flash memory to be updated in place under the control of the CPU, providing an efficient method of updating program and data.

2. Flash Memory Features

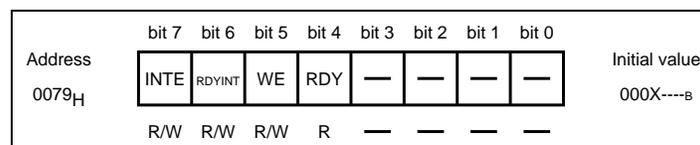
- 16 K byte × 8-bit configuration or 8 K byte × 8-bit configuration*
- Automatic programming algorithm (Embedded Algorithm)
- Data polling and toggle bit for detection of program/erase completion
- Detection of program/erase completion via CPU interrupt
- Compatible with JEDEC-standard commands
- No. of program / erase cycles : Minimum 10,000

* : Check section "Memory Space".

3. Procedure for Programming and Erasing Flash Memory

Programming and reading flash memory cannot be performed at the same time. Accordingly, to program or erase flash memory, the program must first be copied from flash memory to RAM so that programming can be performed without program access from flash memory. Also for flash memory program or erase, a high voltage (instead of an external pullup) must be applied to external reset \overline{RST} pin. Check section "6. MB89F202RA Flash Memory Program/Erase Characteristics" in "■ ELECTRICAL CHARACTERISTICS".

4. Flash Memory Control Status Register (FMCS)



5. Memory Space

The series has 1 flash memory size configuration. The memory space for the CPU access and for the flash programmer access of the configuration is listed below. Check section "6. MB89F202RA Flash Memory Program/Erase Characteristics" in "■ ELECTRICAL CHARACTERISTICS".

Part Number	Memory size	CPU address	Programmer address
MB89F202RA	16 K bytes	FFFF _H to C000 _H	3FFF _H to 0000 _H

6. Flash Programmer Adapter and Recommended Flash Programmers

- Parallel programmer

Part number	Package	Adapter Part number
MB89F202RAP-G-SHE1	DIP-32P-M06	SA653
MB89F202RAPFV-GE1	FPT-34P-M03	SA689

- Serial programmer (PC programmer)

Part number	Package	Adapter Part number
MB89F202RAP-G-SHE1	DIP-32P-M06	MB91919-817
MB89F202RAPFV-GE1	FPT-34P-M03	MB91919-816

MB89202RA Series

7. Flash Content Protection

Flash content can be read using parallel / serial programmer if the flash content protection mechanism is not activated.

One predefined area of the flash (FFFC_H) is assigned to be used for preventing the read access of flash content. If the protection code "01_H" is written in this address (FFFC_H), the flash content cannot be read by any parallel/ serial programmer.

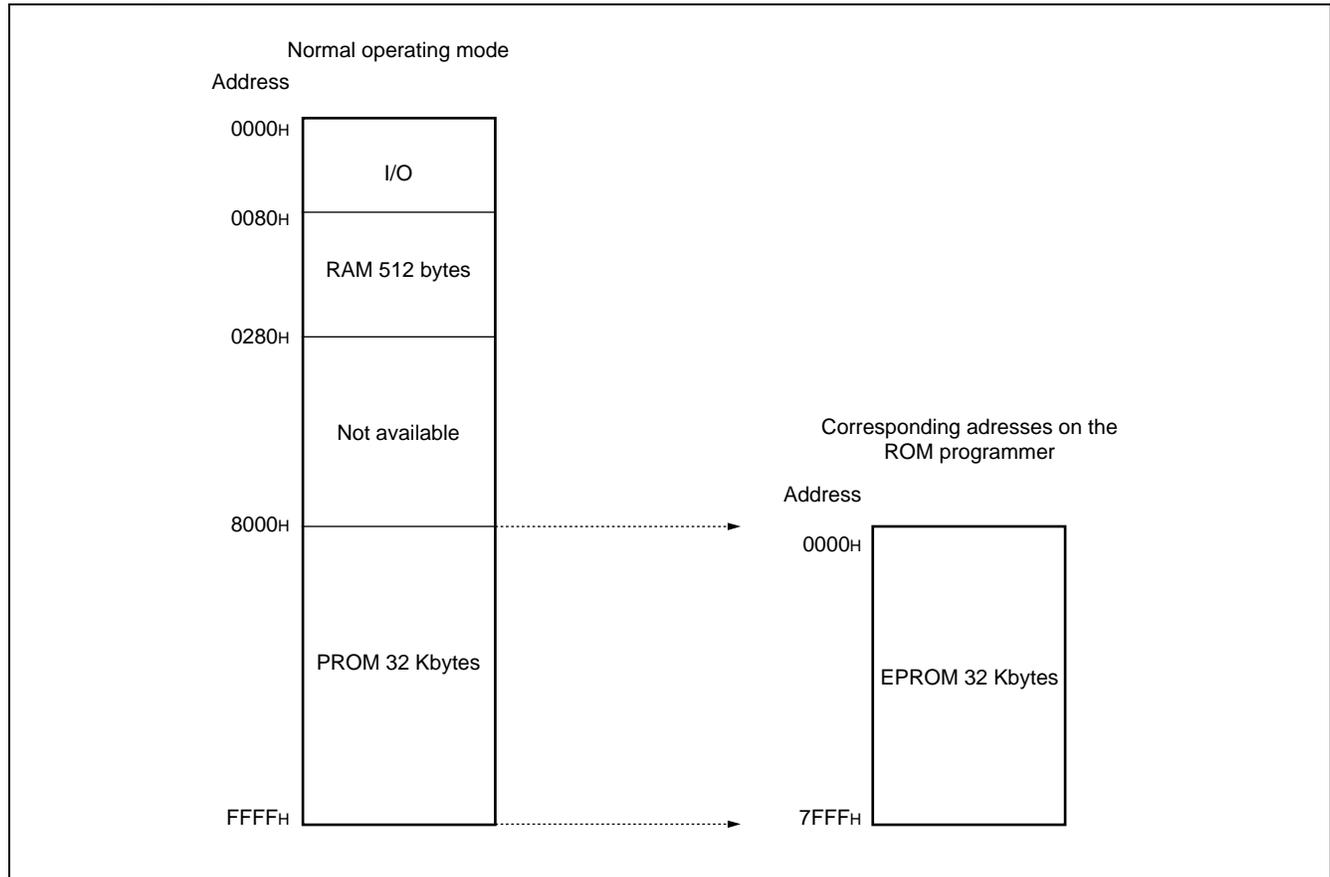
Note : The program written into the flash cannot be verified once the flash protection code is written ("01_H" in FFFC_H). It is advised to write the flash protection code at last.

■ PROGRAMMING TO THE EPROM WITH EVALUATION PRODUCT DEVICE

1. EPROM for Use

MBM27C256A (DIP-28)

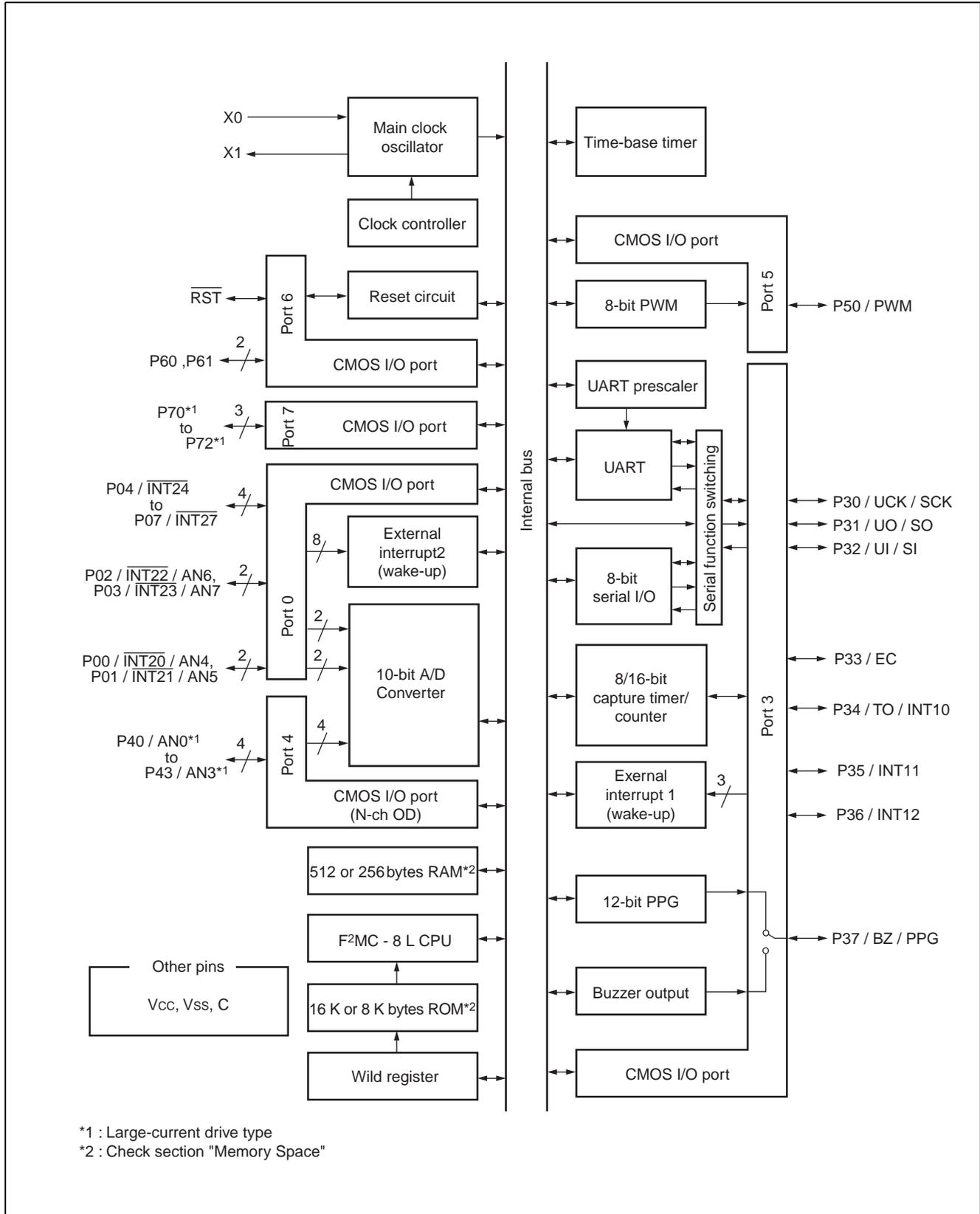
2. Memory Space



3. Programming to the EPROM

- (1) Set the EPROM programmer to the MBM27C256A.
- (2) Load program data into the EPROM programmer at 0000_H to 7FFF_H.
- (3) Program to 0000_H to 7FFF_H with the EPROM programmer.

■ BLOCK DIAGRAM

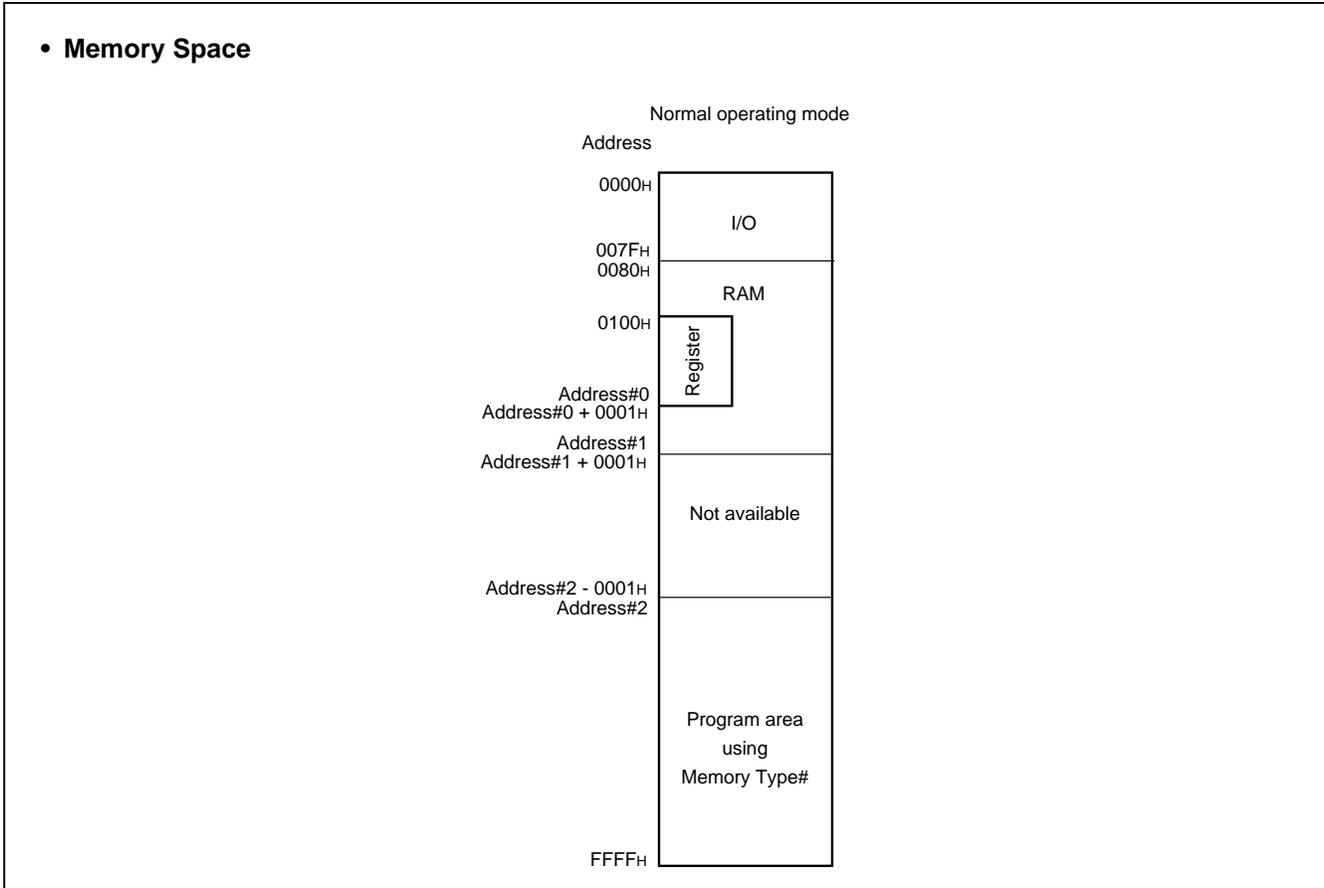


MB89202RA Series

■ CPU CORE

1. Memory Space

The microcontrollers of the MB89202RA series offer a memory space of 64 Kbytes for storing all of I/O, data, and program areas. The I/O area is located at the lowest address. The data area is provided immediately above the I/O area. The data area can be divided into register, stack, and direct areas according to the application. The program area is located at exactly the opposite end, that is, near the highest address. Provide the tables of interrupt reset vectors and vector call instructions toward the highest address within the program area. The memory space of the MB89202RA series is structured as illustrated below.



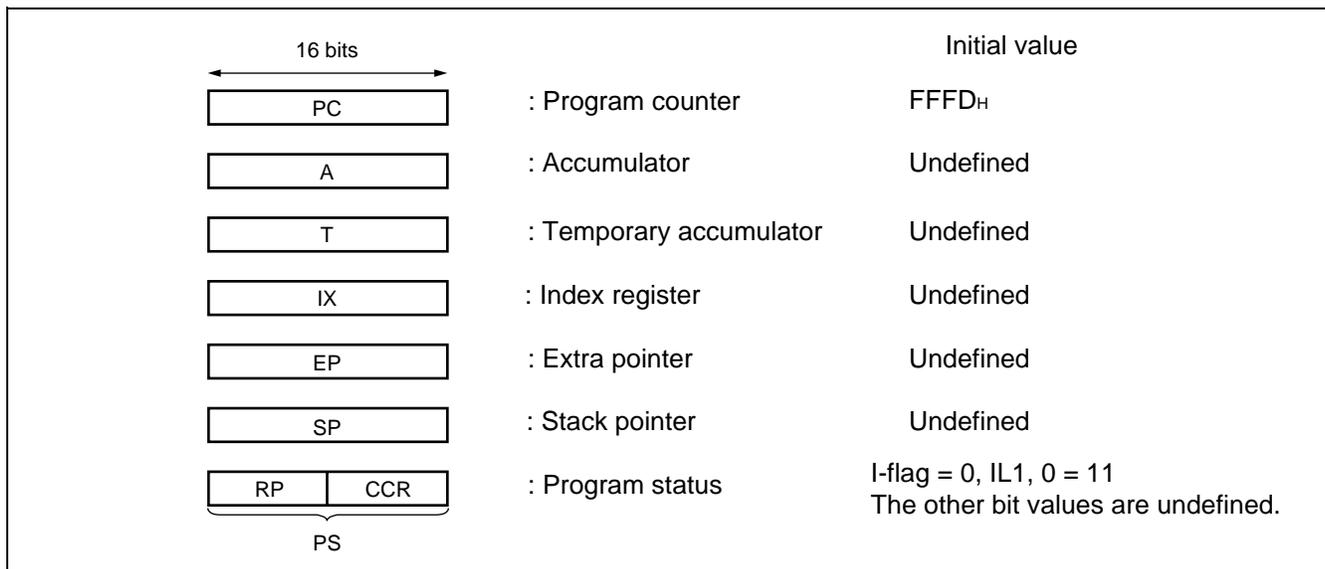
Part Number	RAM size	Address#0	Address#1
MB89V201/F202RA/202	512 bytes	01FF _H	027F _H

Part Number	Memory Type#	Address#2
MB89V201	32 Kbytes External EPROM	8000 _H
MB89F202RA	16 Kbytes Internal Flash Memory	C000 _H
MB89202	16 Kbytes ROM	C000 _H

2. Registers

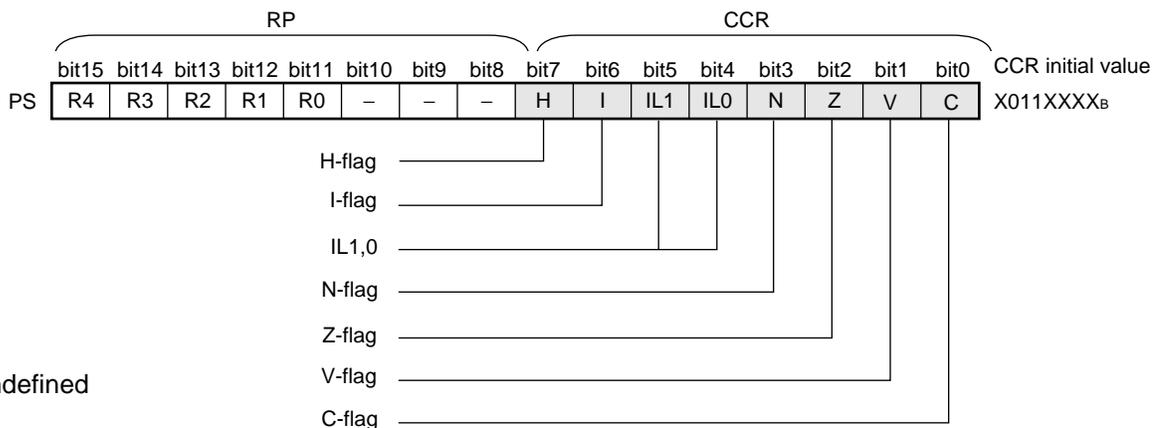
The MB89202RA series has two types of registers; dedicated registers in the CPU and general-purpose registers in the memory. The following dedicated registers are provided :

- Program counter (PC) : A 16-bit register for indicating instruction storage positions
- Accumulator (A) : A 16-bit temporary register for storing arithmetic operations, etc. When the instruction is an 8-bit data processing instruction, the lower byte is used.
- Temporary accumulator (T) : A 16-bit register which performs arithmetic operations with the accumulator
When the instruction is an 8-bit data processing instruction, the lower byte is used.
- Index register (IX) : A 16-bit register for index modification
- Extra pointer (EP) : A 16-bit pointer for indicating a memory address
- Stack pointer (SP) : A 16-bit register for indicating a stack area
- Program status (PS) : A 16-bit register for storing a register pointer, a condition code



The PS can further be divided into higher 8 bits for use as a register bank pointer (RP) and the lower 8 bits for use as a condition code register (CCR) . (See the diagram below.)

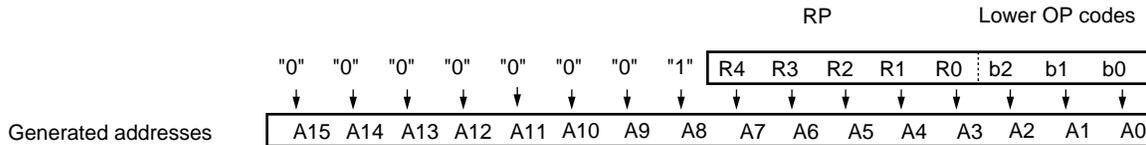
• Structure of the Program Status Register



MB89202RA Series

The RP indicates the address of the register bank currently in use. The relationship between the pointer contents and the actual address is based on the conversion rule illustrated below.

• **Rule for Conversion of Actual Addresses of the General-purpose Register Area**



The CCR consists of bits indicating the results of arithmetic operations and the contents of transfer data and bits for control of CPU operations at the time of an interrupt.

H-flag : Set to "1" when a carry or a borrow from bit 3 to bit 4 occurs as a result of an arithmetic operation. Cleared to "0" otherwise. This flag is for decimal adjustment instructions.

I-flag : Interrupt is enabled when this flag is set to "1". Interrupt is disabled when the flag is cleared to "0". Cleared to "0" at the reset.

IL1, 0 : Indicates the level of the interrupt currently allowed. Processes an interrupt only if its request level is higher than the value indicated by this bit.

IL1	IL0	Interrupt level	High-low
0	0	1	High ↑ ↓ Low = no interrupt
0	1		
1	0	2	
1	1	3	

N-flag : Set to "1" if the MSB becomes to "1" as the result of an arithmetic operation. Cleared to "0" when the bit is cleared to "0".

Z-flag : Set to "1" when an arithmetic operation results in 0. Cleared to "0" otherwise.

V-flag : Set to "1" if the complement on 2 overflows as a result of an arithmetic operation. Cleared to "0" if the overflow does not occur.

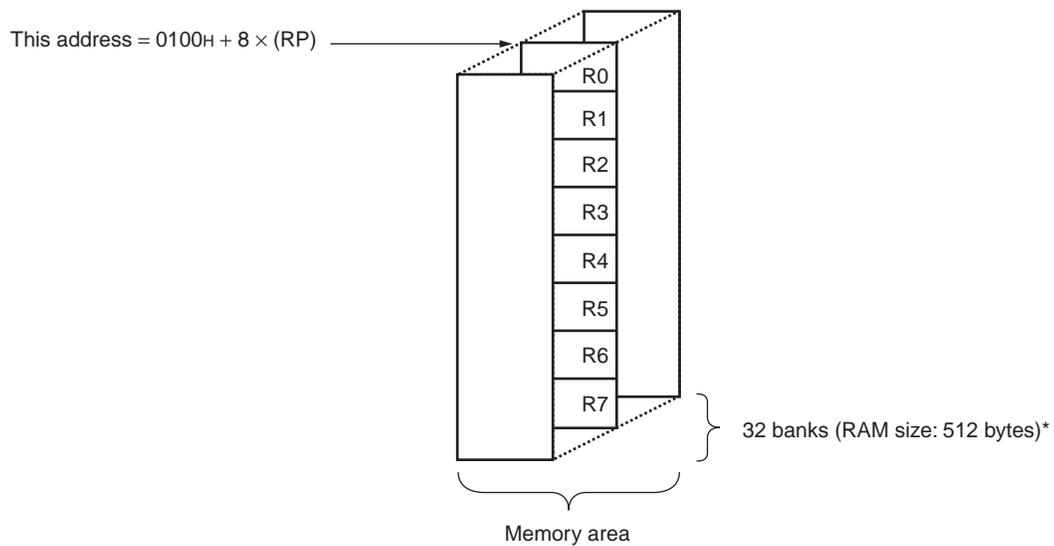
C-flag : Set to "1" when a carry or a borrow from bit 7 occurs as a result of an arithmetic operation. Cleared to "0" otherwise. Set to the shift-out value in the case of a shift instruction.

The following general-purpose registers are provided :

General-purpose registers : An 8-bit register for storing data

The general-purpose registers are 8 bits and located in the register banks of the memory. One bank contains eight registers and up to a total of 32 banks (in 512 RAM size) can be used in the MB89202RA series. The bank currently in use is indicated by the register bank pointer (RP) .

• Register Bank Configuration



* : Check section "Memory Space"

MB89202RA Series

■ I/O MAP

Address	Register name	Register description	Read/write	Initial value
0000 _H	PDR0	Port 0 data register	R/W	X X X X X X X X _B
0001 _H	DDR0	Port 0 data direction register	W	0 0 0 0 0 0 0 0 _B
0002 _H to 0006 _H	Reserved			
0007 _H	SYCC	System clock control register	R/W	1 - - 1 1 1 0 0 _B
0008 _H	STBC	Standby control register	R/W	0 0 0 1 0 - - - _B
0009 _H	WDTC	Watchdog timer control register	R/W	0 - - - X X X X _B
000A _H	TBTC	Time-base timer control register	R/W	0 0 - - - 0 0 0 _B
000B _H	Reserved			
000C _H	PDR3	Port 3 data register	R/W	X X X X X X X X _B
000D _H	DDR3	Port 3 data direction register	W	0 0 0 0 0 0 0 0 _B
000E _H	RSFR	Reset flag register	R	X X X X - - - - _B
000F _H	PDR4	Port 4 data register	R/W	- - - - X X X X _B
0010 _H	DDR4	Port 4 data direction register	R/W	- - - - 0 0 0 0 _B
0011 _H	OUT4	Port 4 output format register	R/W	- - - - 0 0 0 0 _B
0012 _H	PDR5	Port 5 data register	R/W	- - - - - - - X _B
0013 _H	DDR5	Port 5 data direction register	R/W	- - - - - - - 0 _B
0014 _H	RCR21	12-bit PPG control register 1	R/W	0 0 0 0 0 0 0 0 _B
0015 _H	RCR22	12-bit PPG control register 2	R/W	- - 0 0 0 0 0 0 _B
0016 _H	RCR23	12-bit PPG control register 3	R/W	0 - 0 0 0 0 0 0 _B
0017 _H	RCR24	12-bit PPG control register 4	R/W	- - 0 0 0 0 0 0 _B
0018 _H	BZCR	Buzzer register	R/W	- - - - - 0 0 0 _B
0019 _H	TCCR	Capture control register	R/W	0 0 0 0 0 0 0 0 _B
001A _H	TCR1	Timer 1 control register	R/W	0 0 0 - 0 0 0 0 _B
001B _H	TCR0	Timer 0 control register	R/W	0 0 0 0 0 0 0 0 _B
001C _H	TDR1	Timer 1 data register	R/W	X X X X X X X X _B
001D _H	TDR0	Timer 0 data register	R/W	X X X X X X X X _B
001E _H	TCPH	Capture data register H	R	X X X X X X X X _B
001F _H	TCPL	Capture data register L	R	X X X X X X X X _B
0020 _H	TCR2	Timer output control register	R/W	- - - - - - 0 0 _B
0021 _H	Reserved			
0022 _H	CNTR	PWM control register	R/W	0 - 0 0 0 0 0 0 _B
0023 _H	COMR	PWM compare register	W	X X X X X X X X _B
0024 _H	EIC1	External interrupt 1 Control register 1	R/W	0 0 0 0 0 0 0 0 _B

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MB89202RA Series

Address	Register name	Register description	Read/write	Initial value
0025 _H	EIC2	External interrupt 1 Control register 2	R/W	- - - - 0 0 0 0 _B
0026 _H	Reserved			
0027 _H				
0028 _H	SMC	Serial mode control register	R/W	0 0 0 0 0 - 0 0 _B
0029 _H	SRC	Serial rate control register	R/W	- - 0 1 1 0 0 0 _B
002A _H	SSD	Serial status and data register	R/W	0 0 1 0 0 - 1 X _B
002B _H	SIDR	Serial input data register	R	X X X X X X X X _B
	SODR	Serial output data register	W	X X X X X X X X _B
002C _H	UPC	Clock division selection register	R/W	- - - - 0 0 1 0 _B
002D _H to 002F _H	Reserved			
0030 _H	ADC1	A/D control register 1	R/W	- 0 0 0 0 0 0 0 _B
0031 _H	ADC2	A/D control register 2	R/W	- 0 0 0 0 0 0 1 _B
0032 _H	ADDH	A/D data register H	R	- - - - - X X _B
0033 _H	ADDL	A/D data register L	R	X X X X X X X X _B
0034 _H	ADEN	A/D enable register	R/W	0 0 0 0 0 0 0 _B
0035 _H	Reserved			
0036 _H	EIE2	External interrupt 2 control register1	R/W	0 0 0 0 0 0 0 _B
0037 _H	EIF2	External interrupt 2 control register2	R/W	- - - - - - 0 _B
0038 _H	Reserved			
0039 _H	SMR	Serial mode register	R/W	0 0 0 0 0 0 0 _B
003A _H	SDR	Serial data register	R/W	X X X X X X X X _B
003B _H	SSEL	Serial function switching register	R/W	- - - - - - 0 _B
003C _H to 003F _H	Reserved			
0040 _H	WRARH0	Upper-address setting register 0	R/W	X X X X X X X X _B
0041 _H	WRARL0	Lower-address setting register 0	R/W	X X X X X X X X _B
0042 _H	WRDR0	Data setting register 0	R/W	X X X X X X X X _B
0043 _H	WRARH1	Upper-address setting register 1	R/W	X X X X X X X X _B
0044 _H	WRARL1	Lower-address setting register 1	R/W	X X X X X X X X _B
0045 _H	WRDR1	Data setting register 1	R/W	X X X X X X X X _B
0046 _H	WREN	Address comparison EN register	R/W	X X X X X X 0 0 _B
0047 _H	WROR	Wild-register data test register	R/W	- - - - - - 0 0 _B
0048 _H to 005F _H	Reserved			

(Continued)

MB89202RA Series

(Continued)

Address	Register name	Register description	Read/write	Initial value
0060H	PDR6	Port 6 data register	R/W	- - - - - X X _B
0061H	DDR6	Port 6 data direction register*	R/W	- - - - - 0 0 _B
0062H	PUL6	Port 6 pull-up setting register*	R/W	- - - - - 0 0 _B
0063H	PDR7	Port 7 data register	R/W	- - - - - X X X _B
0064H	DDR7	Port 7 data direction register	R/W	- - - - - 0 0 0 _B
0065H	PUL7	Port 7 pull-up setting register	R/W	- - - - - 0 0 0 _B
0066H to 006FH	Reserved			
0070H	PUL0	Port 0 pull-up setting register	R/W	0 0 0 0 0 0 0 0 _B
0071H	PUL3	Port 3 pull-up setting register	R/W	0 0 0 0 0 0 0 0 _B
0072H	PUL5	Port 5 pull-up setting register	R/W	- - - - - 0 _B
0073H to 0078H	Reserved			
0079H	FMCS	Flash memory control status register	R/W	0 0 0 X - - - _B
007AH	Reserved			
007BH	ILR1	Interrupt level setting register1	W	1 1 1 1 1 1 1 1 _B
007CH	ILR2	Interrupt level setting register2	W	1 1 1 1 1 1 1 1 _B
007DH	ILR3	Interrupt level setting register3	W	1 1 1 1 1 1 1 1 _B
007EH	ILR4	Interrupt level setting register4	W	1 1 1 1 1 1 1 1 _B
007FH	ITR	Interrupt test register	Not available	- - - - - 0 0 _B

- : Unused, X : Undefined

* : No used in MB89F202RA

Note: Do not use prohibited areas.

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*	V_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
Input voltage*	V_I	$V_{SS} - 0.3$	$V_{CC} + 0.3$	V	
Output voltage*	V_O	$V_{SS} - 0.3$	$V_{CC} + 6.0$	V	
"L" level maximum output current	I_{OL}	—	15	mA	
"L" level average output current	I_{OLAV1}	—	4	mA	Average value (operating current × operating rate) Pins excluding P40 to P43, P70 to P72
	I_{OLAV2}	—	12	mA	Average value (operating current × operating rate) Pins P40 to P43, P70 to P72
"L" level total maximum output current	ΣI_{OL}	—	100	mA	
"H" level maximum output current	I_{OH}	—	-10	mA	Pins excluding P60, P61
"H" level average output current	I_{OHAV}	—	-4	mA	Average value (operating current × operating rate)
"H" level total maximum output current	ΣI_{OH}	—	-50	mA	
Power consumption	P_d	—	200	mW	
Operating temperature	T_a	-40	+85	°C	
Storage temperature	T_{stg}	-55	+150	°C	

* : This parameter is based on $V_{SS} = 0.0$ V.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

MB89202RA Series

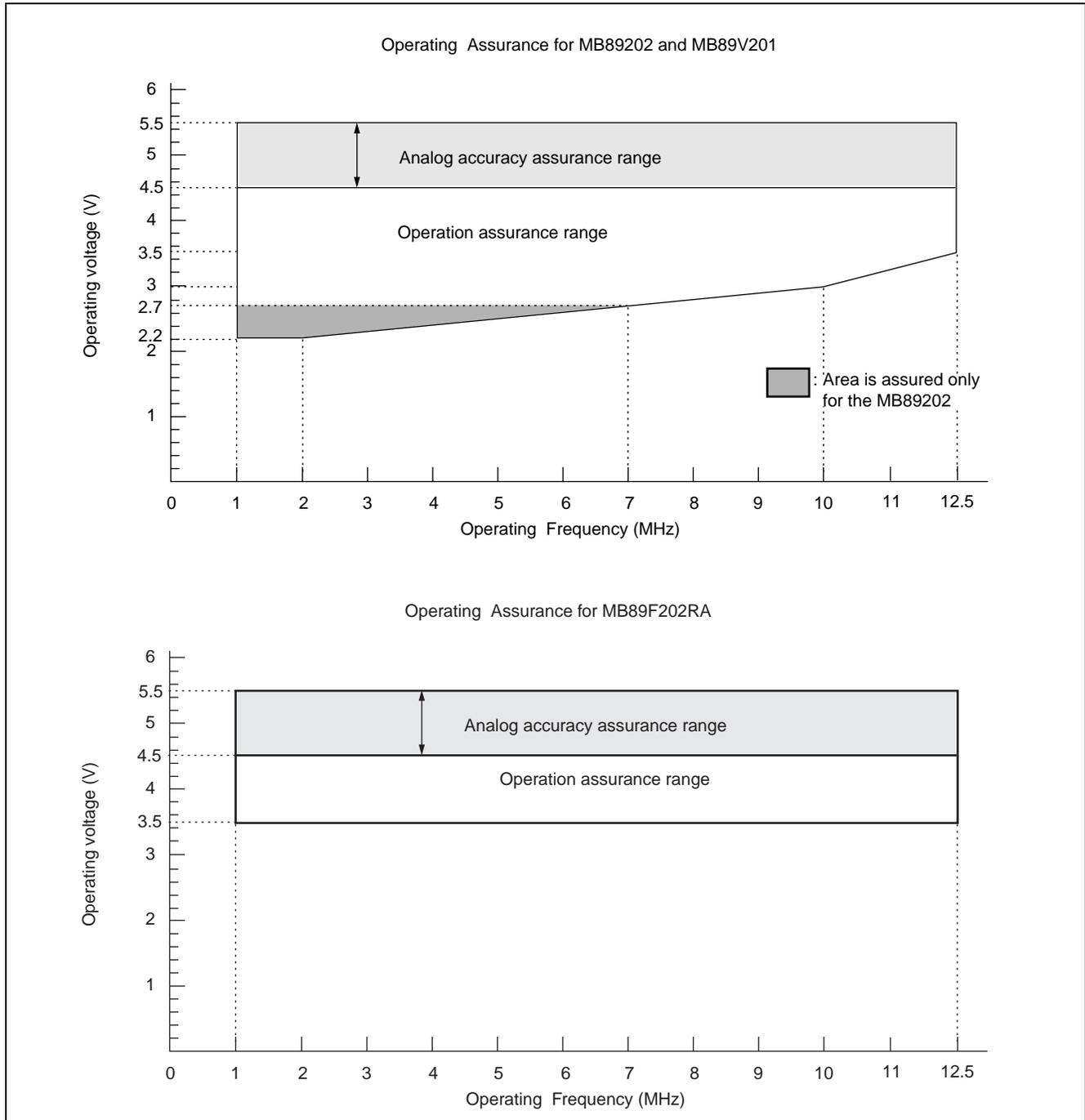
2. Recommended Operating Conditions

(V_{SS} = 0.0V)

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
Power supply voltage	V _{CC}	2.2	5.5	V	MB89202
		3.5	5.5	V	MB89F202RA
		2.7	5.5	V	MB89V201
		1.5	5.5	V	Retains the RAM state in stop mode
“H” level input voltage	V _{IH}	0.7 V _{CC}	V _{CC} + 0.3	V	P00 to P07, P31, P37, P40 to P43, P50, P60, P61, P70 to P72
	V _{IHS}	0.8 V _{CC}	V _{CC} + 0.3	V	$\overline{\text{RST}}$ *, EC, $\overline{\text{INT20}}$ to $\overline{\text{INT27}}$, UCK/SCK, INT10 to INT12, P30, P32 to P36, UI/SI
“L” level input voltage	V _{IL}	V _{SS} - 0.3	0.3 V _{CC}	V	P00 to P07, P31, P37, P40 to P43, P50, P60, P61, P70 to P72
	V _{ILS}	V _{SS} - 0.3	0.2 V _{CC}	V	$\overline{\text{RST}}$, EC, $\overline{\text{INT20}}$ to $\overline{\text{INT27}}$, UCK/SCK, INT10 to INT12, P30, P32 to P36, UI/SI
Open-drain output pin application voltage	V _D	V _{SS} - 0.3	V _{CC} + 0.3	V	P40 to P43, $\overline{\text{RST}}$
Operating temperature	T _a	-40	+85	°C	Room temperature is recommended for programming the flash memory on MB89F202RA

* : $\overline{\text{RST}}$ acts as high voltage supply for the flash memory during program and erase on MB89F202RA. It can tolerate high voltage input. Please check section “ 6. MB89F202RA Flash Memory Program/Erase Characteristics”.

MB89202RA Series



WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

MB89202RA Series

3. DC Characteristics

($V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = 0.0 \text{ V}$, $F_{CH} = 12.5 \text{ MHz}$ (External clock), $T_a = -40 \text{ }^\circ\text{C}$ to $+85 \text{ }^\circ\text{C}$)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
“H” level input voltage	V_{IH}	P00 to P07, P31, P37, P40 to P43, P50, P60, P61, P70 to P72	—	0.7 V_{CC}	—	$V_{CC} + 0.3$	V	
	V_{IHS}	P30, P32 to P36, \overline{RST}^* , $\overline{UCK/SCK}$, $\overline{UI/SI}$, EC, $\overline{INT20}$ to $\overline{INT27}$, INT10 to INT12	—	0.8 V_{CC}	—	$V_{CC} + 0.3$	V	
“L” level input voltage	V_{IL}	P00 to P07, P31, P37, P40 to P43, P50, P60, P61, P70 to P72	—	$V_{SS} - 0.3$	—	0.3 V_{CC}	V	
	V_{ILS}	P30, P32 to P36, \overline{RST} , $\overline{UCK/SCK}$, $\overline{UI/SI}$, EC, $\overline{INT20}$ to $\overline{INT27}$, INT10 to INT12	—	$V_{SS} - 0.3$	—	0.2 V_{CC}	V	
Open-drain output pin application voltage	V_D	P40 to P43, \overline{RST}	—	$V_{SS} - 0.3$	—	$V_{CC} + 0.3$	V	
“H” level output voltage	V_{OH}	P00 to P07, P30 to P37, P40 to P43, P50, P70 to P72	$I_{OH} = -4.0 \text{ mA}$	4.0	—	—	V	
“L” level output voltage	V_{OL1}	P00 to P07, P30 to P37, P50, \overline{RST}	$I_{OL} = 4.0 \text{ mA}$	—	—	0.4	V	
	V_{OL2}	P40 to P43, P70 to P72	$I_{OL} = 12.0 \text{ mA}$	—	—	0.4	V	
Input leakage current	I_{LI}	P00 to P07, P30 to P37, P40 to P43, P50, P60, P61, \overline{RST} , P70 to P72	$0.45 \text{ V} < V_I < V_{CC}$	—	—	± 5	μA	Without pull-up resistor
Pull-up resistance	R_{PULL}	P00 to P07, P30 to P37, P50, \overline{RST} , P70 to P72	$V_I = 0.0 \text{ V}$	25	50	100	k Ω	MB89202
		P00 to P07, P30 to P37, P50, P70 to P72						MB89F202 RA

(Continued)

MB89202RA Series

(Continued)

Parameter	Sym- bol	Pin name	Condition	Value			Unit	Remarks	
				Min	Typ	Max			
Power supply current	I _{CC}	V _{CC}	Normal operation mode (External clock, highest gear speed)	When A/D converter stops	—	8	12	mA	MB89202
				When A/D converter starts	—	10	15	mA	MB89202
			Sleep mode (External clock, highest gear speed)	When A/D converter stops	—	4	6	mA	MB89202
	When A/D converter starts			—	3	5	mA	MB89F202 RA	
				Stop mode T _a = +25 °C (External clock)	When A/D converter stops	—	—	1	μA
	I _{CCS}		Stop mode T _a = +25 °C (External clock)		When A/D converter stops	—	—	10	μA
I _{CCH}	When A/D converter stops	—		—	10	μA	MB89F202 RA		
Input capacitance	C _{IN}	Other than C, V _{CC} , V _{SS}	—	—	10	—	pF		

* : $\overline{\text{RST}}$ acts as high voltage supply for the flash memory during program and erase on MB89F202RA. It can tolerate high voltage input. Please check section “ 6. MB89F202RA Flash Memory Program/Erase Characteristics”.

MB89202RA Series

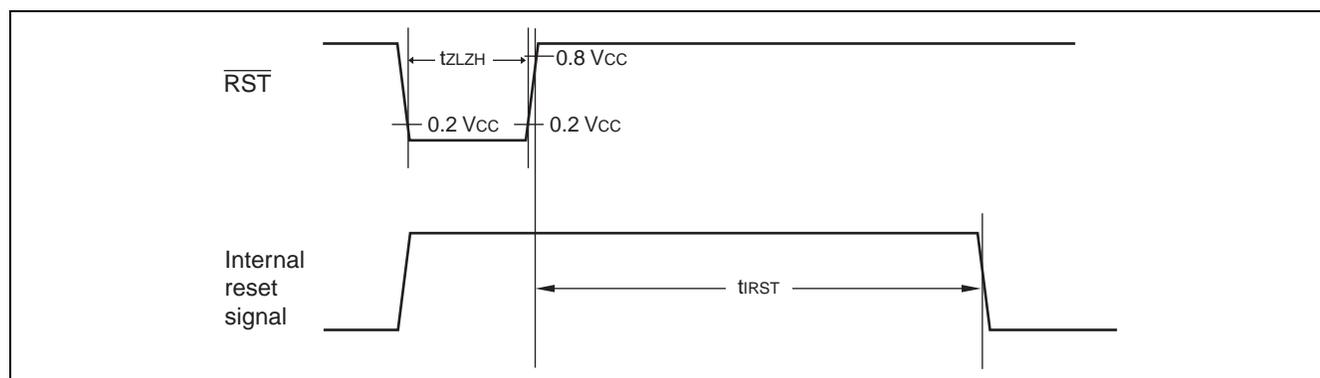
4. AC Characteristics

(1) Reset Timing

($V_{SS} = 0.0\text{ V}$, $T_a = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Condition	Value		Unit
			Min	Max	
$\overline{\text{RST}}$ "L" pulse width	t_{ZLZH}	—	45	—	ns
Internal reset pulse extension	t_{IRST}	—	$48 t_{\text{HCYL}}^*$	—	ns

* : t_{HCYL} 1 oscillating clock cycle time

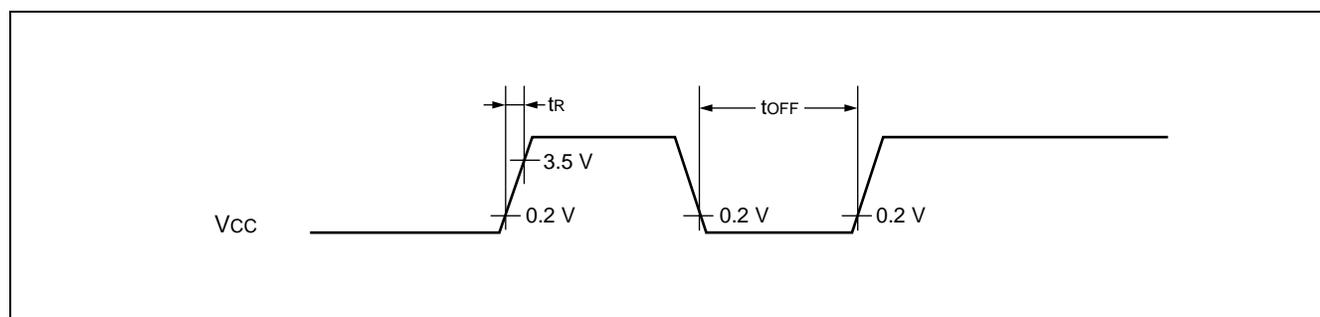


Note: If the reset pulse applied to the external reset pin ($\overline{\text{RST}}$) does not meet the specifications, it may cause malfunctions. Use caution so that the reset pulse less than the specifications will not be fed to the external reset pin ($\overline{\text{RST}}$).

(2) Power-on Reset

($V_{SS} = 0.0\text{ V}$, $T_a = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min	Max		
Power supply rising time	t_{R}	—	—	50	ms	
Power supply cut-off time	t_{OFF}	—	1	—	ms	Due to repeated operations



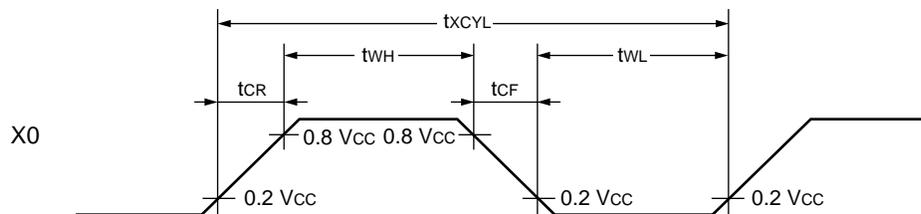
Note: : The supply voltage must be set to the minimum value required for operation within the prescribed default oscillation settling time.

(3) Clock Timing

($V_{SS} = 0.0\text{ V}$, $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

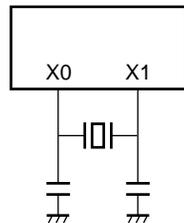
Parameter	Symbol	Condition	Value		Unit
			Min	Max	
Clock frequency	F_{CH}	—	1	12.5	MHz
Clock cycle time	t_{xCYL}		80	1000	ns
Input clock pulse width	t_{WH} t_{WL}		20	—	ns
Input clock rising/falling time	t_{CR} t_{CF}		—	10	ns

• X0 and X1 Timing and Conditions

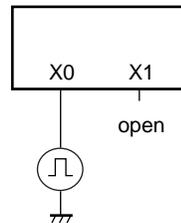


• Main Clock Conditions

When a crystal or ceramic resonator is used



When an external clock is used



(4) Instruction Cycle

Parameter	Symbol	Value (typical)	Unit	Remarks
Instruction cycle (minimum execution time)	t_{INST}	$4/F_{CH}$, $8/F_{CH}$, $16/F_{CH}$, $64/F_{CH}$	μs	$t_{INST} = 0.32\ \mu\text{s}$ when operating at $F_{CH} = 12.5\ \text{MHz}$ ($4/F_{CH}$)

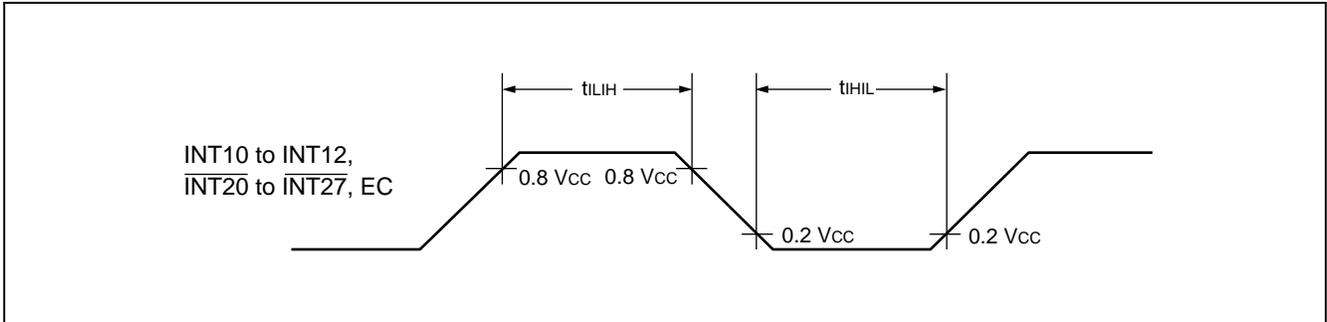
MB89202RA Series

(5) Peripheral Input Timing

($V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $T_a = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

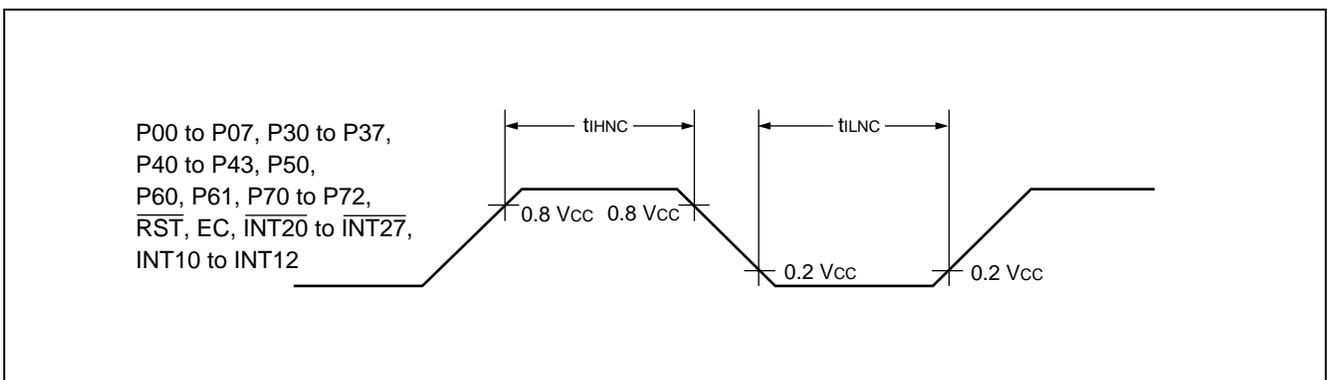
Parameter	Symbol	Pin name	Value		Unit
			Min	Max	
Peripheral input "H" pulse width	t_{ILIH}	INT10 to INT12, INT20 to INT27, EC	$2 t_{INST}^*$	—	μs
Peripheral input "L" pulse width	t_{IHIL}	INT10 to INT12, INT20 to INT27, EC	$2 t_{INST}^*$	—	μs

* : For information on t_{INST} see "(4) Instruction Cycle".



($V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $T_a = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

Parameter	Symbol	Pin name	Value			Unit
			Min	Typ	Max	
Peripheral input "H" noise limit	t_{IHNC}	P00 to P07, P30 to P37, P40 to P43, P50, P60, P61, P70 to P72, RST, EC, INT20 to INT27, INT10 to INT12	—	45	—	ns
Peripheral input "L" noise limit	t_{ILNC}		—	45	—	ns



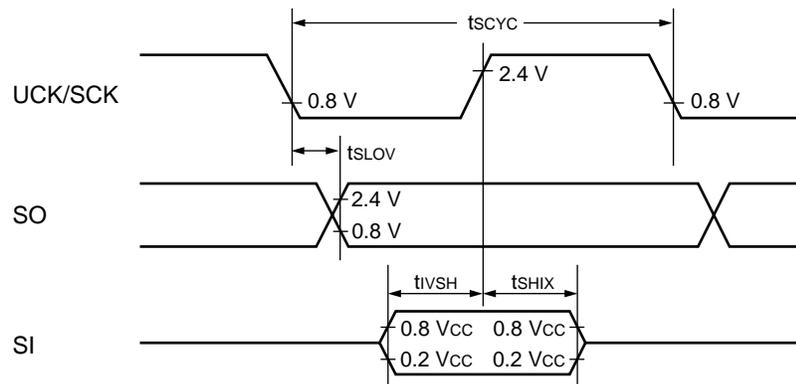
(6) UART, Serial I/O Timing

($V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $T_a = -40\text{ }^\circ\text{C}$ to $+85\text{ }^\circ\text{C}$)

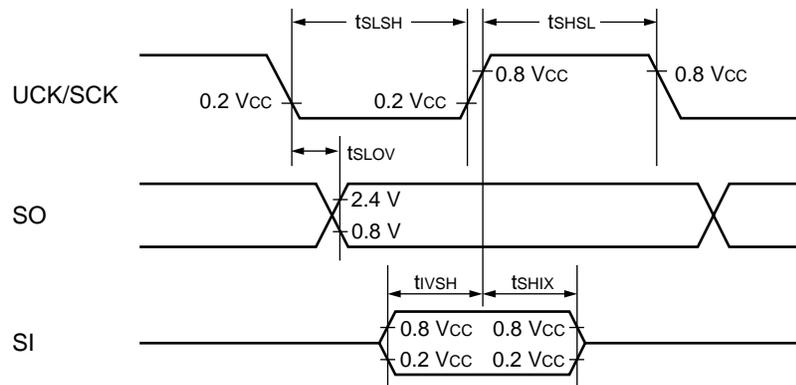
Parameter	Symbol	Pin name	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	UCK/SCK	Internal shift clock mode	$2 t_{INST}^*$	—	μs
UCK/SCK $\downarrow \rightarrow$ SO time	t_{SLOV}	UCK/SCK, SO		-200	+200	ns
Valid SI \rightarrow UCK/SCK \uparrow	t_{IVSH}	UCK/SCK, SI		$1/2 t_{INST}^*$	—	μs
UCK/SCK $\uparrow \rightarrow$ Valid SI hold time	t_{SHIX}	UCK/SCK, SI		$1/2 t_{INST}^*$	—	μs
Serial clock "H" pulse width	t_{SHSL}	UCK/SCK	External shift clock mode	t_{INST}^*	—	μs
Serial clock "L" pulse width	t_{SLSH}	UCK/SCK		t_{INST}^*	—	μs
UCK/SCK $\downarrow \rightarrow$ SO time	t_{SLOV}	UCK/SCK, SO		0	200	ns
Valid SI \rightarrow UCK/SCK	t_{IVSH}	UCK/SCK, SI		$1/2 t_{INST}^*$	—	μs
UCK/SCK $\uparrow \rightarrow$ Valid SI hold time	t_{SHIX}	UCK/SCK, SI		$1/2 t_{INST}^*$	—	μs

* : For information on t_{inst} , see "(4) Instruction Cycle".

• Internal Shift Clock Mode



• External Shift Clock Mode



MB89202RA Series

5. A/D Converter

(1) A/D Converter Electrical Characteristics

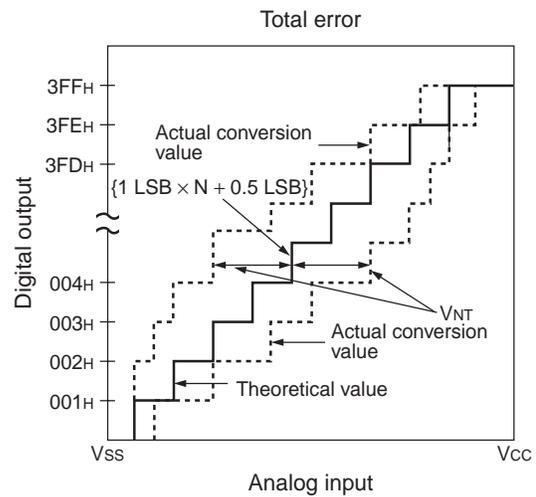
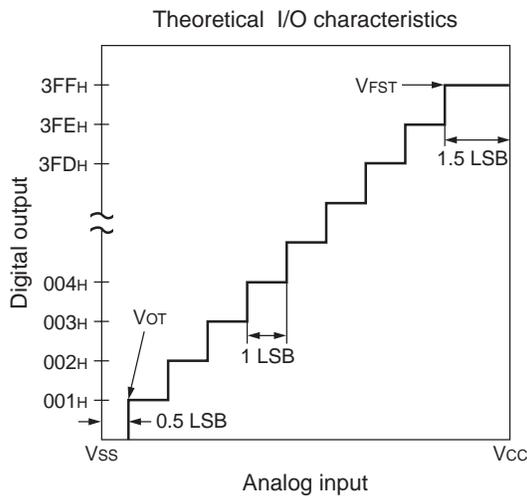
($V_{SS} = 0.0 \text{ V}$, $T_a = -40 \text{ }^\circ\text{C}$ to $+85 \text{ }^\circ\text{C}$)

Parameter	Symbol	Value			Unit
		Min	Typ	Max	
Resolution	—	—	—	10	bit
Total error		-5.0	—	+5.0	LSB
Linearity error		-3.0	—	+3.0	LSB
Differential linearity error		-2.5	—	+2.5	LSB
Zero transition voltage	V_{OT}	$V_{SS} - 3.5 \text{ LSB}$	$V_{SS} + 0.5 \text{ LSB}$	$V_{SS} + 4.5 \text{ LSB}$	V
Full-scale transition voltage	V_{FST}	$V_{CC} - 6.5 \text{ LSB}$	$V_{CC} - 1.5 \text{ LSB}$	$V_{CC} + 2.0 \text{ LSB}$	V
A/D mode conversion time	—	—	—	$38 t_{INST}^*$	μs
Analog port input current	I_{AIN}	—	—	10	μA
Analog input voltage range	—	0	—	V_{CC}	V
Power supply voltage for A/D accuracy assurance	V_{CC}	4.5	—	5.5	V

* : For information on t_{inst} , see “(4) Instruction Cycle” in “4. AC Characteristics.”

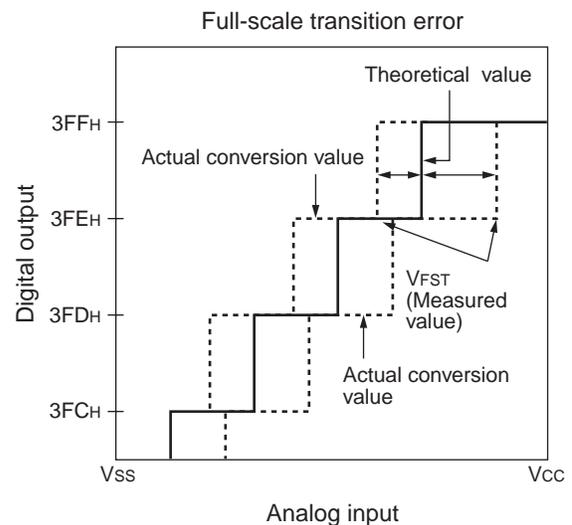
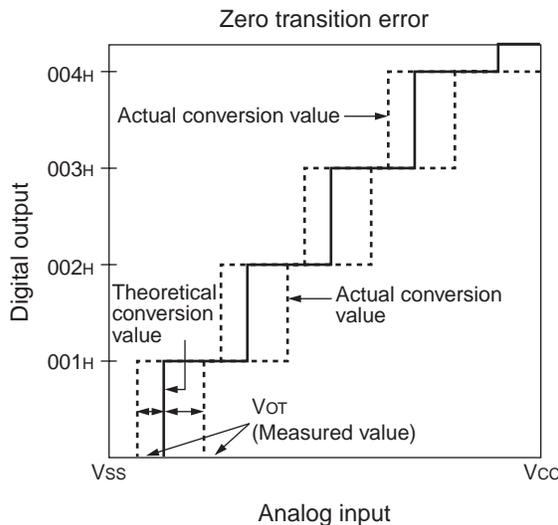
(2) A/D Converter Glossary

- Resolution
Analog changes that are identifiable with the A/D converter
When the number of bits is 10, analog voltage can be divided into $2^{10} = 1024$.
- Linearity error (unit : LSB)
The deviation of the straight line connecting the zero transition point ("00 0000 0000" ↔ "00 0000 0001") with the full-scale transition point ("11 1111 1111" ↔ "11 1111 1110") from actual conversion characteristics
- Differential linearity error (unit : LSB)
The deviation of input voltage needed to change the output code by 1 LSB from the theoretical value
- Total error (unit : LSB)
The difference between theoretical and actual conversion values



$$1 \text{ LSB} = \frac{V_{\text{FST}} - V_{\text{OT}}}{1022} \text{ (V)}$$

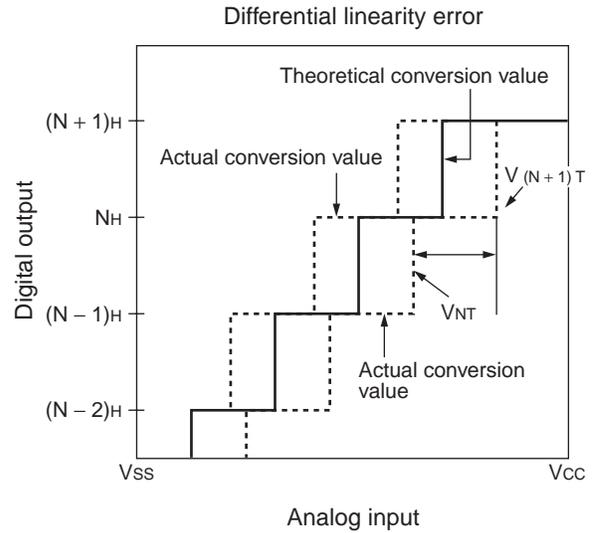
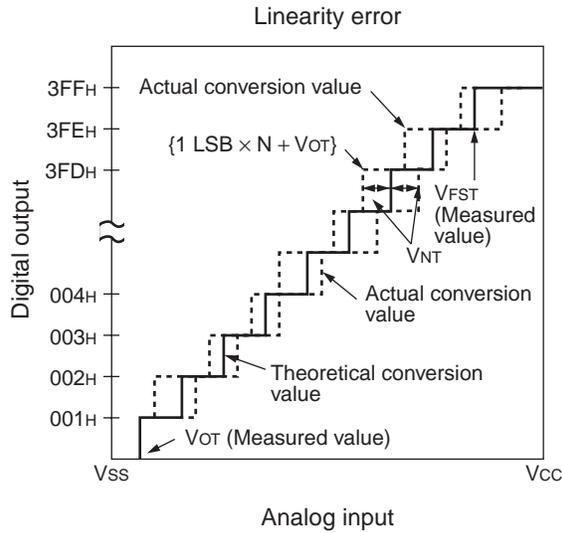
$$\text{Total error of digital output } N = \frac{V_{\text{NT}} - \{1 \text{ LSB} \times N + 0.5 \text{ LSB}\}}{1 \text{ LSB}}$$



(Continued)

MB89202RA Series

(Continued)



$$\text{Linearity error of digital output } N = \frac{V_{NT} - \{1 \text{ LSB} \times N + V_{OT}\}}{1 \text{ LSB}}$$

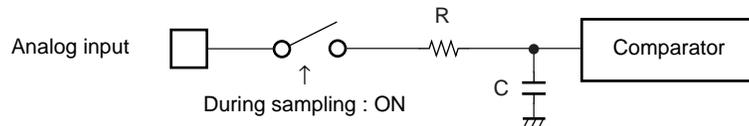
$$\text{Differential linearity error of digital output } N = \frac{V_{(N+1)T} - V_{NT}}{1 \text{ LSB}}$$

(3) Notes on Using A/D Converter

• About the external impedance of analog input and its sampling time

- A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision.

• Analog input circuit model

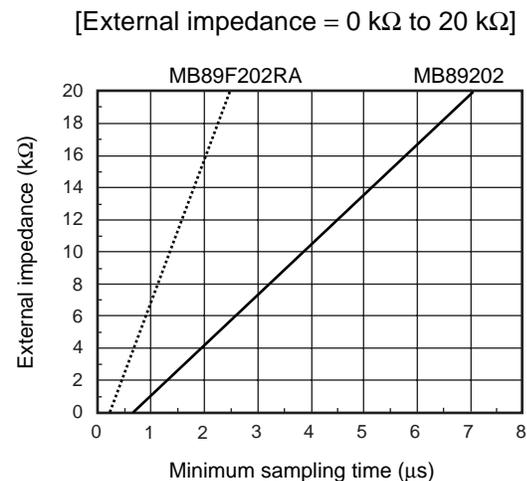
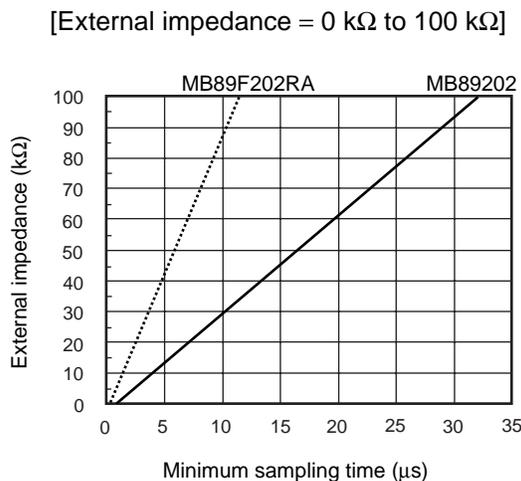


Note: The values are reference values.

	R	C
MB89202	2.2 kΩ (Max)	45 pF (Max)
MB89F202RA	2.0 kΩ (Max)	16 pF (Max)

- To satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value.

• The relationship between the external impedance and minimum sampling time



- If the sampling time cannot be sufficient, connect a capacitor of about 0.1 μF to the analog input pin.

• About errors

As $|V_{CC} - V_{SS}|$ becomes smaller, values of relative errors grow larger.

MB89202RA Series

6. MB89F202RA Flash Memory Program/Erase Characteristics

Parameter	Value			Unit	Remarks
	Min	Typ	Max		
Chip erase time (16 Kbytes)	—	0.5 ^{*1}	7.5 ^{*2}	s	Excludes programming prior to erasure
Byte programming time	—	32	3600	μs	Excludes system-level overhead
Program/Erase cycle	10,000	—	—	cycle	
High voltage source on $\overline{\text{RST}}$	—	12.00	—	V	High voltage must be applied to $\overline{\text{RST}}$ during flash memory program / erase

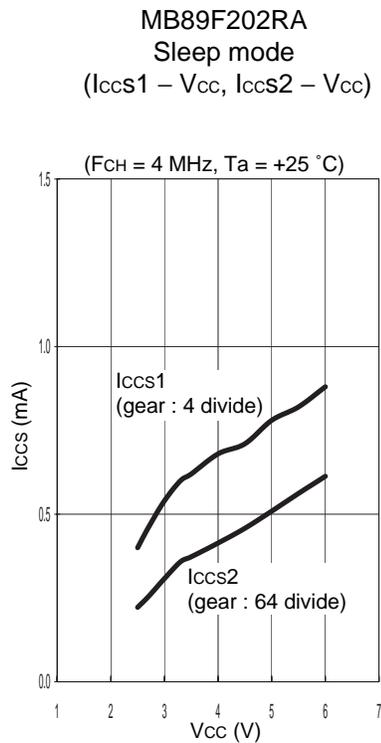
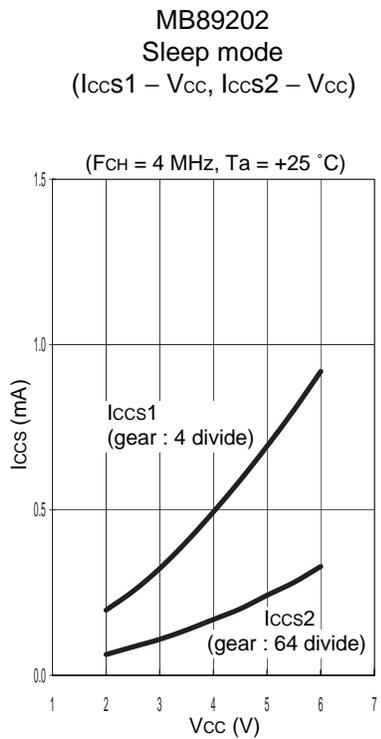
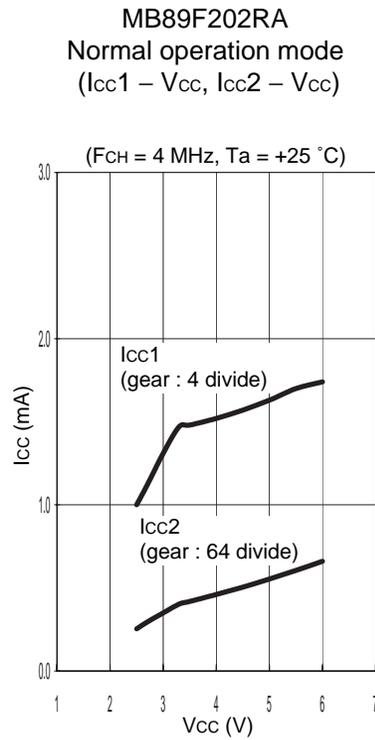
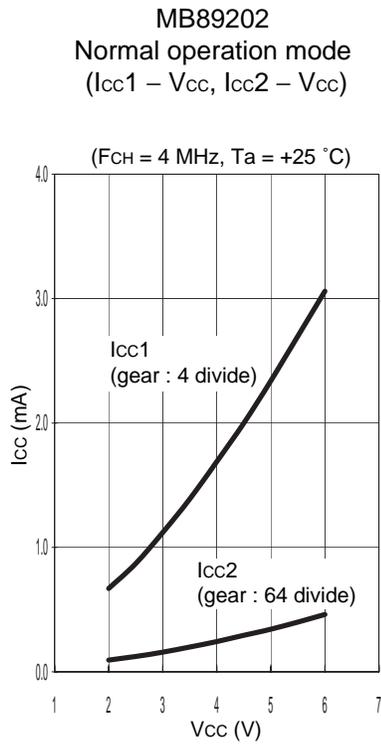
*1: Ta = + 25 °C, Vcc = 3.0 V, 10,000 cycles

*2: Ta = + 85 °C, Vcc = 2.7 V, 10,000 cycles

EXAMPLE CHARACTERISTICS

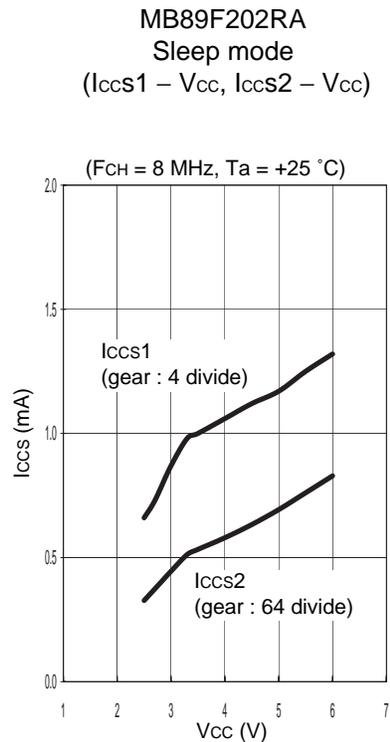
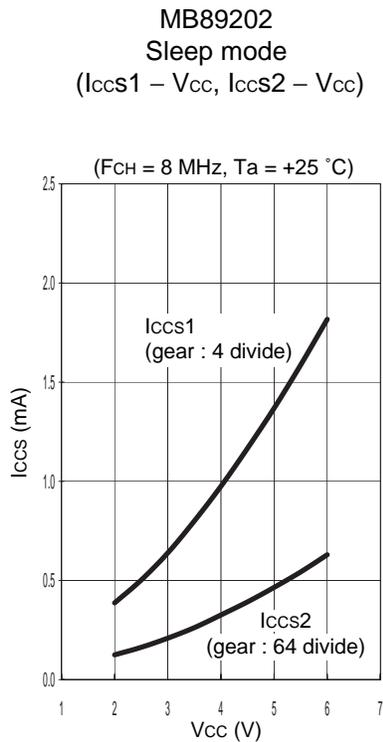
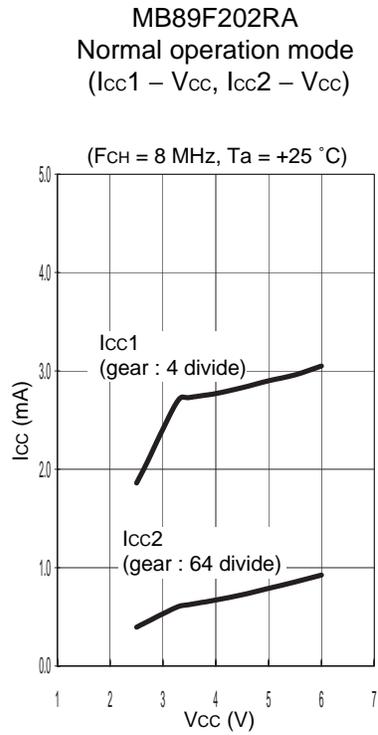
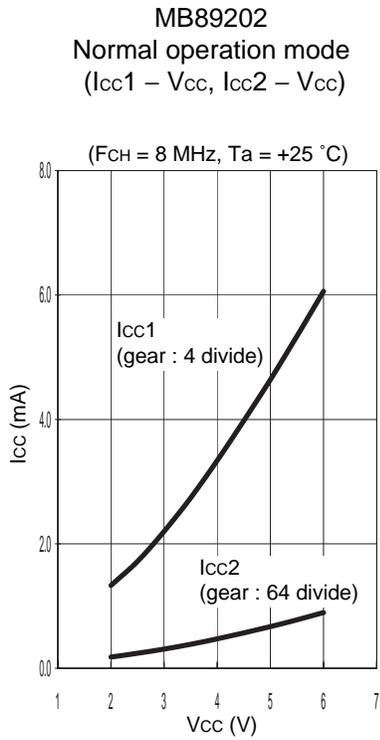
1. Power supply current

- MB89202/F202RA : 4 MHz (when external clock are used)



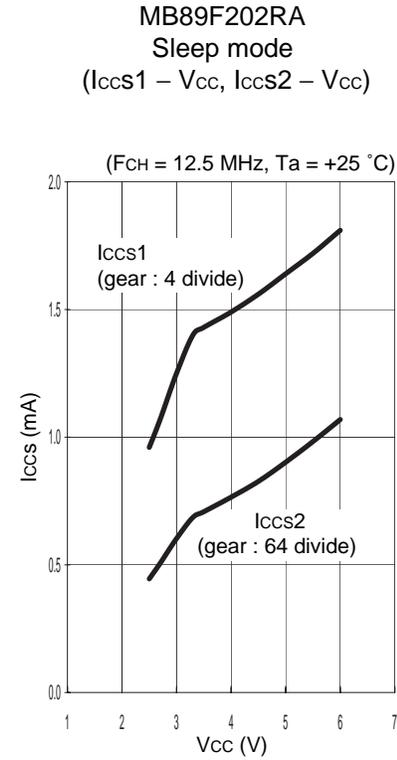
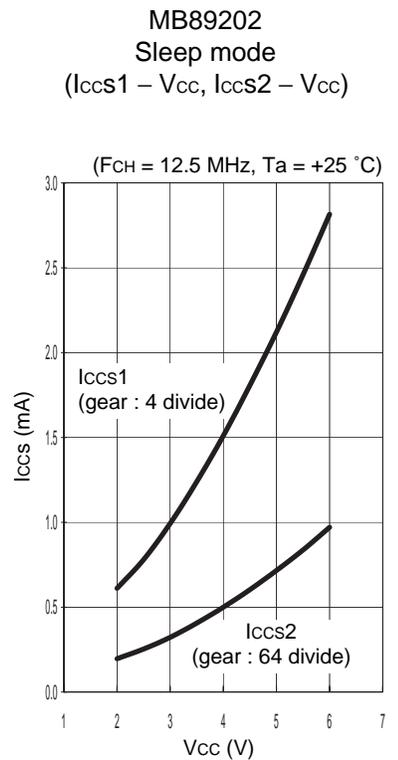
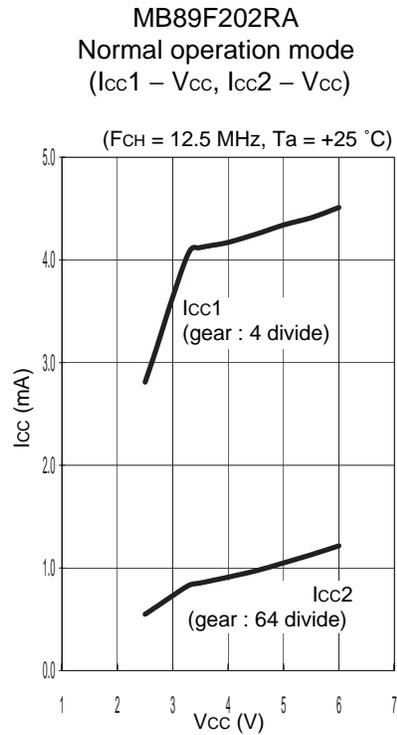
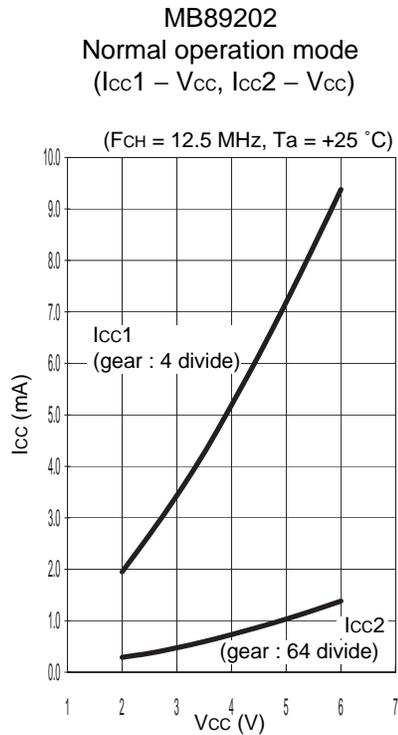
MB89202RA Series

- MB89202/F202RA : 8 MHz (when external clock are used)



MB89202RA Series

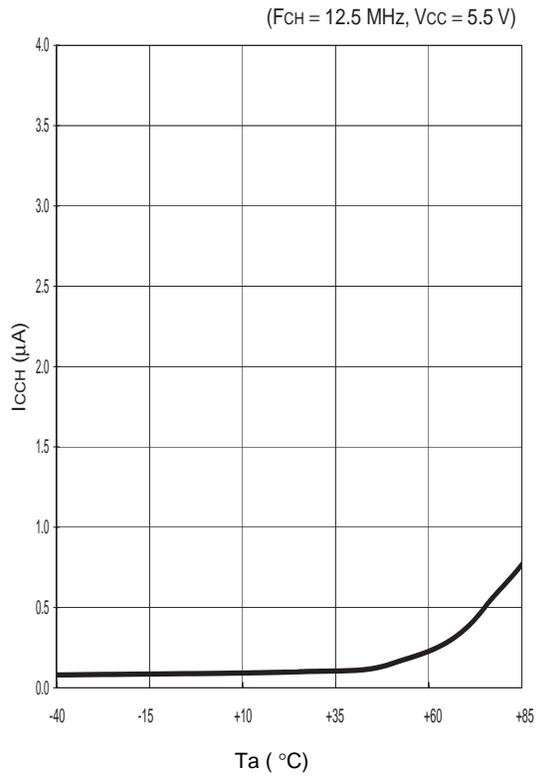
- MB89202/F202RA : 12.5 MHz (when external clock is used)



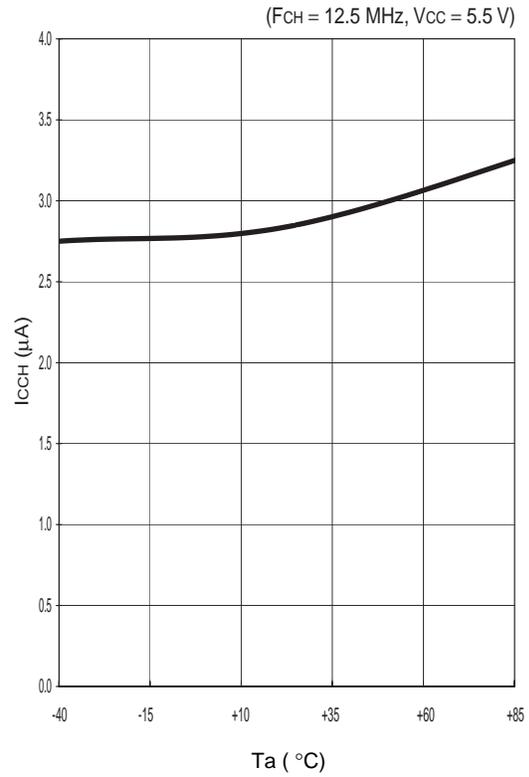
MB89202RA Series

- MB89202/F202RA : 12.5 MHz (when external clock is used)

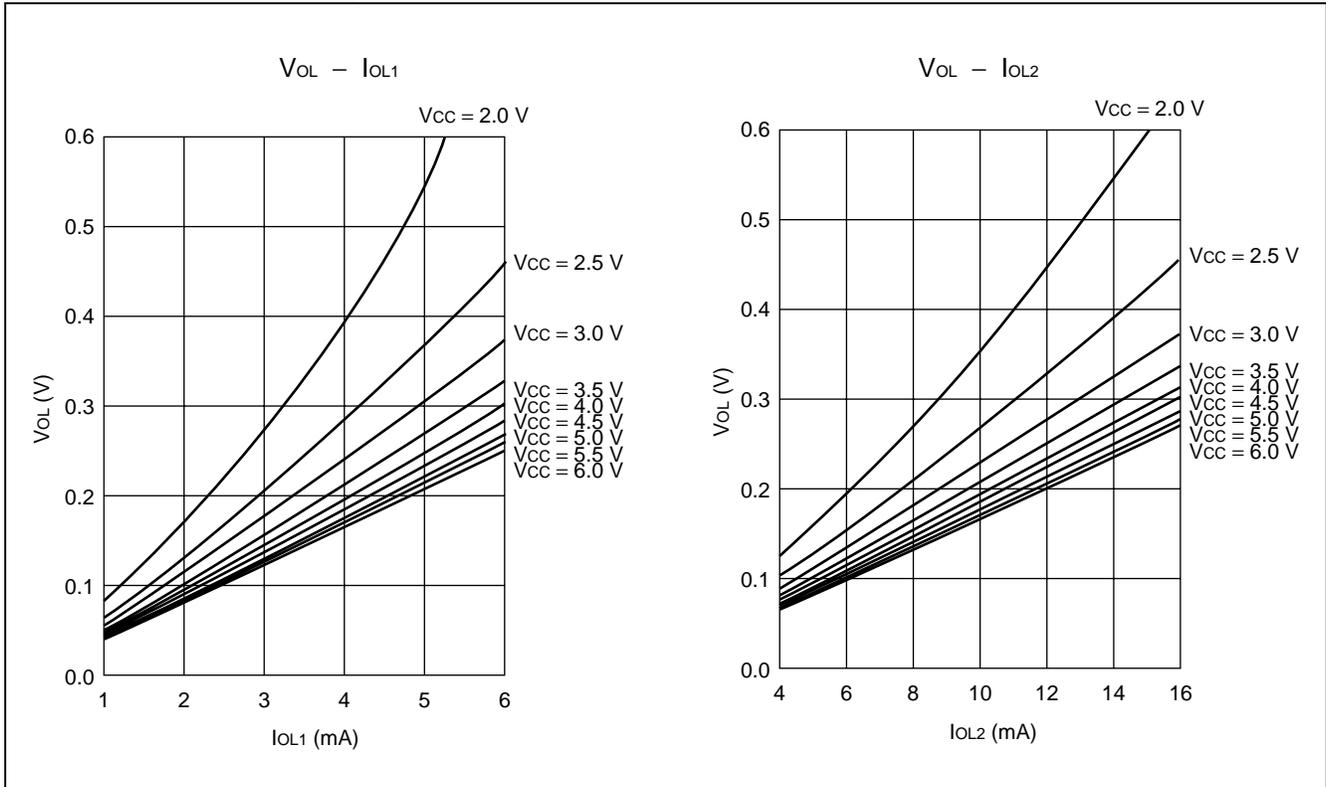
MB89202
Stop mode ($I_{CCH} - T_a$)



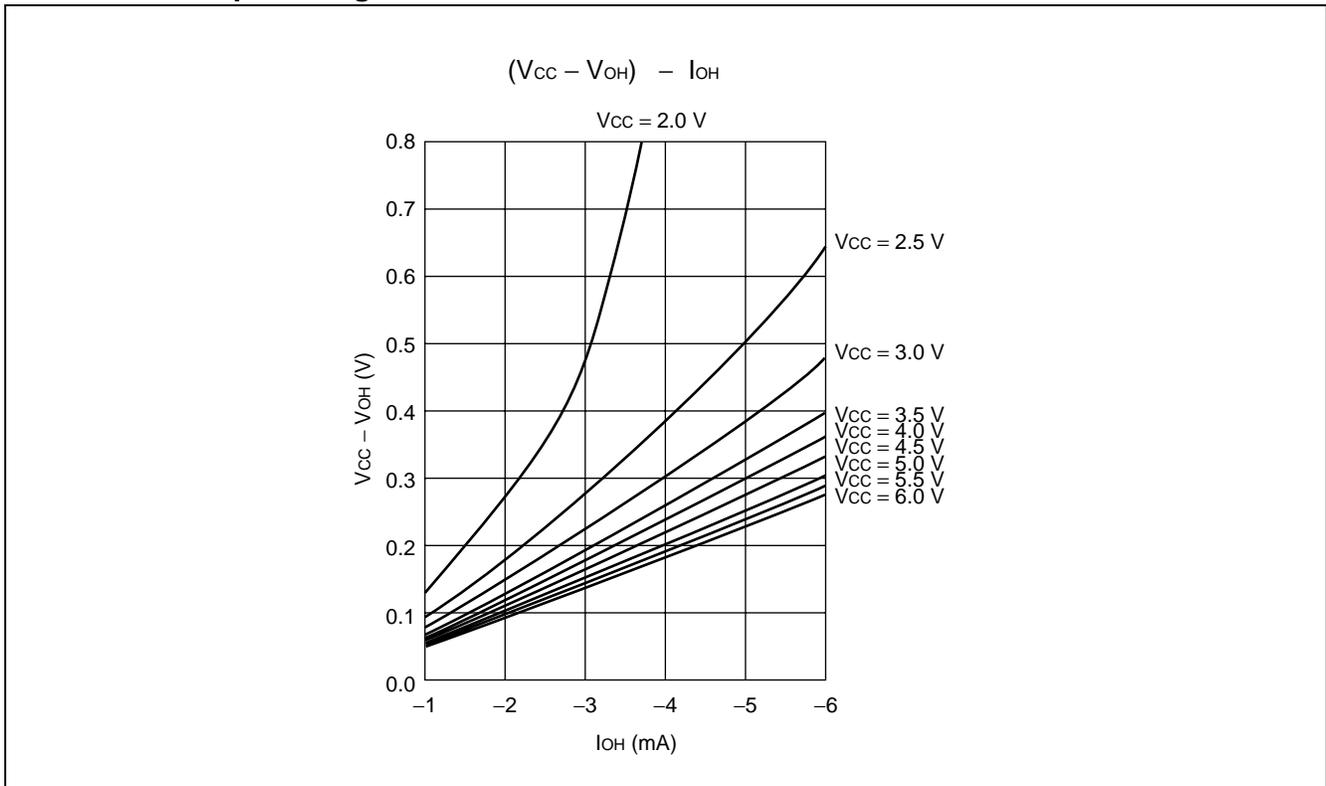
MB89F202RA
Stop mode ($I_{CCH} - T_a$)



2. "L" level output voltage



3. "H" level output voltage



MB89202RA Series

■ MASK OPTIONS

No.	Part number	MB89202	MB89F202RA	MB89V201
	Specified / Fixed	Specified when ordering masking	Fixed	
1	Selection of initial value of main clock oscillation settling time* (with $F_{CH} = 12.5$ MHz) 01 : $2^{14}/F_{CH}$ (Approx.1.31 ms) 10 : $2^{17}/F_{CH}$ (Approx.10.5 ms) 11 : $2^{18}/F_{CH}$ (Approx.21.0 ms)	Selectable	Fixed to $2^{18}/F_{CH}$	Fixed to $2^{18}/F_{CH}$
2	Reset pin output With reset output Without reset output	Selectable	With reset output	With reset output
3	Power on reset selection With power on reset Without power on reset	Selectable	With power on reset	With power on reset

F_{CH} : Main clock oscillation frequency

* : Initial value to which the oscillation settling time bit (SYCC : WT1, WT0) in the system clock control register is set

Note:

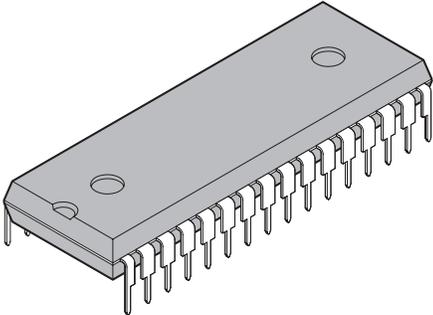
- Notes on selecting mask option

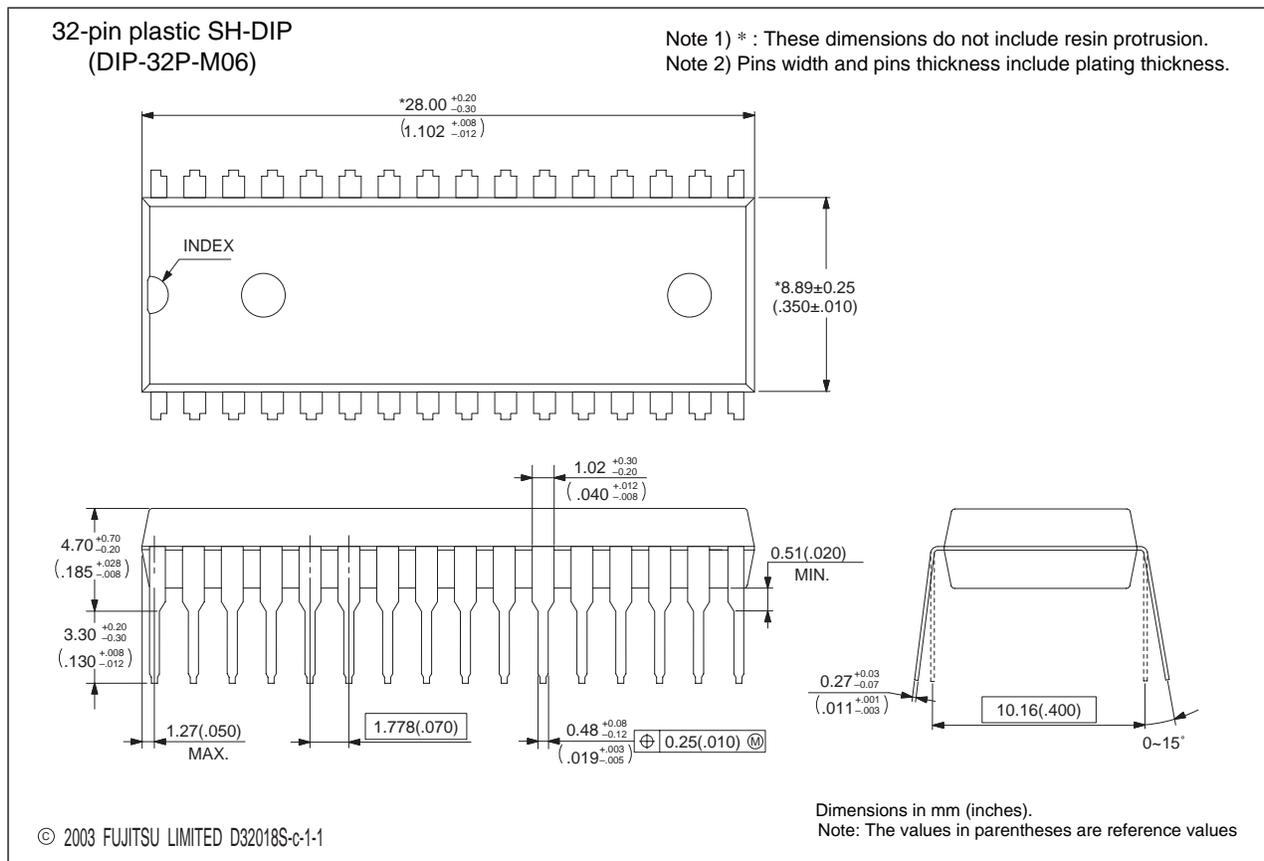
Please select "With reset output" by the mask option when power-on reset is generated at the power supply ON, and the device is used without inputting external reset.

■ ORDERING INFORMATION

Part number	Package
MB89202P-SH	32-pin plastic SH-DIP (DIP-32P-M06)
MB89F202RAP-G-SHE1	
MB89202PFV	34-pin plastic SSOP (FPT-34P-M03)
MB89F202RAPFV-GE1	
MB89V201PFV	64-pin plastic LQFP (FPT-64P-M03)

■ PACKAGE DIMENSIONS

<p>32-pin plastic SH-DIP</p>  <p>(DIP-32P-M06)</p>	Lead pitch	1.778 mm
	Low space	10.16 mm
	Sealing method	Plastic mold

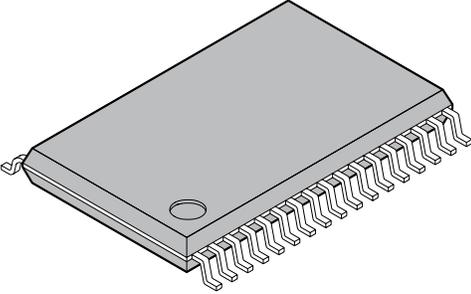


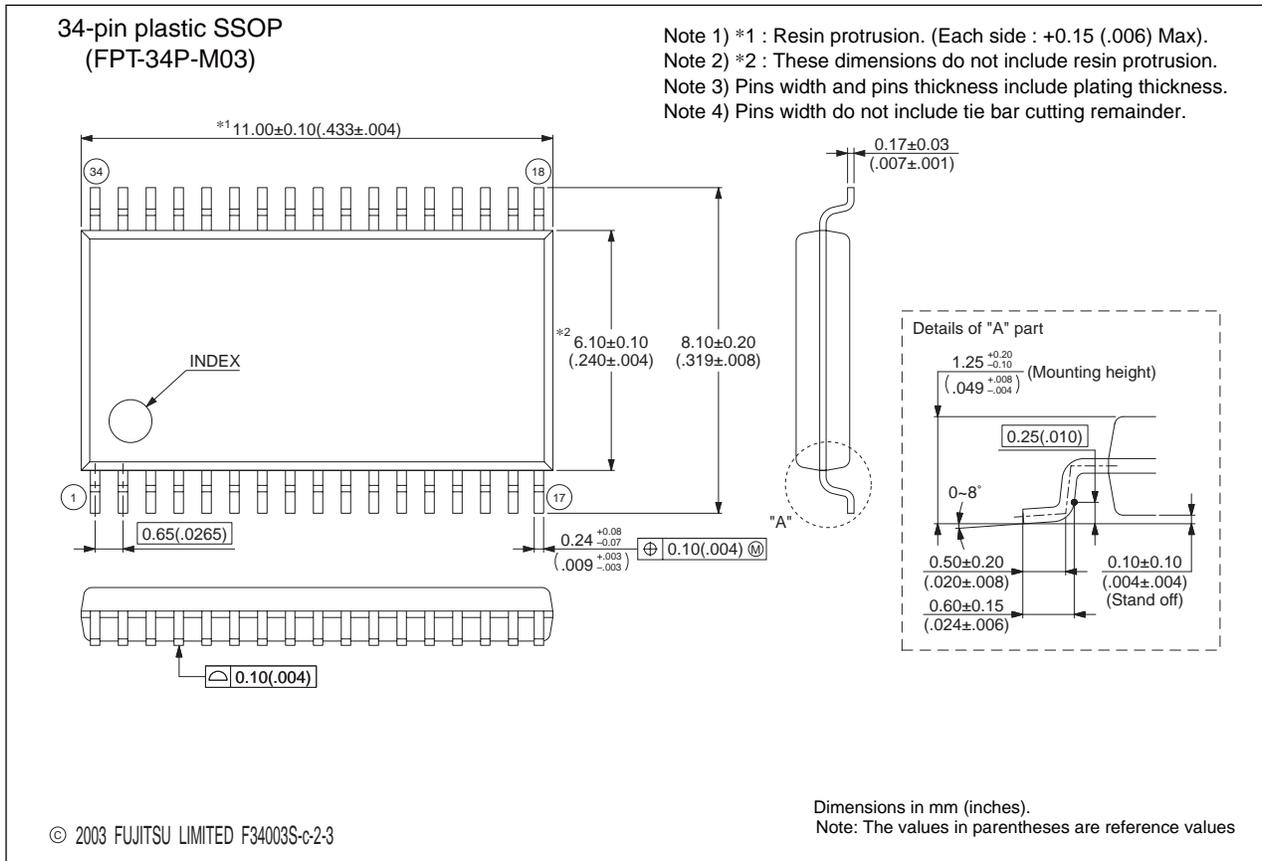
Please confirm the latest Package dimension by following URL.
<http://edevice.fujitsu.com/package/en-search/>

(Continued)

MB89202RA Series

(Continued)

<p style="text-align: center;">34-pin plastic SSOP</p>  <p style="text-align: center;">(FPT-34P-M03)</p>	Lead pitch	0.65 mm
	Package width × package length	6.10 × 11.00 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.45 mm MAX
	Code (Reference)	P-SSOP34-6.1×11-0.65



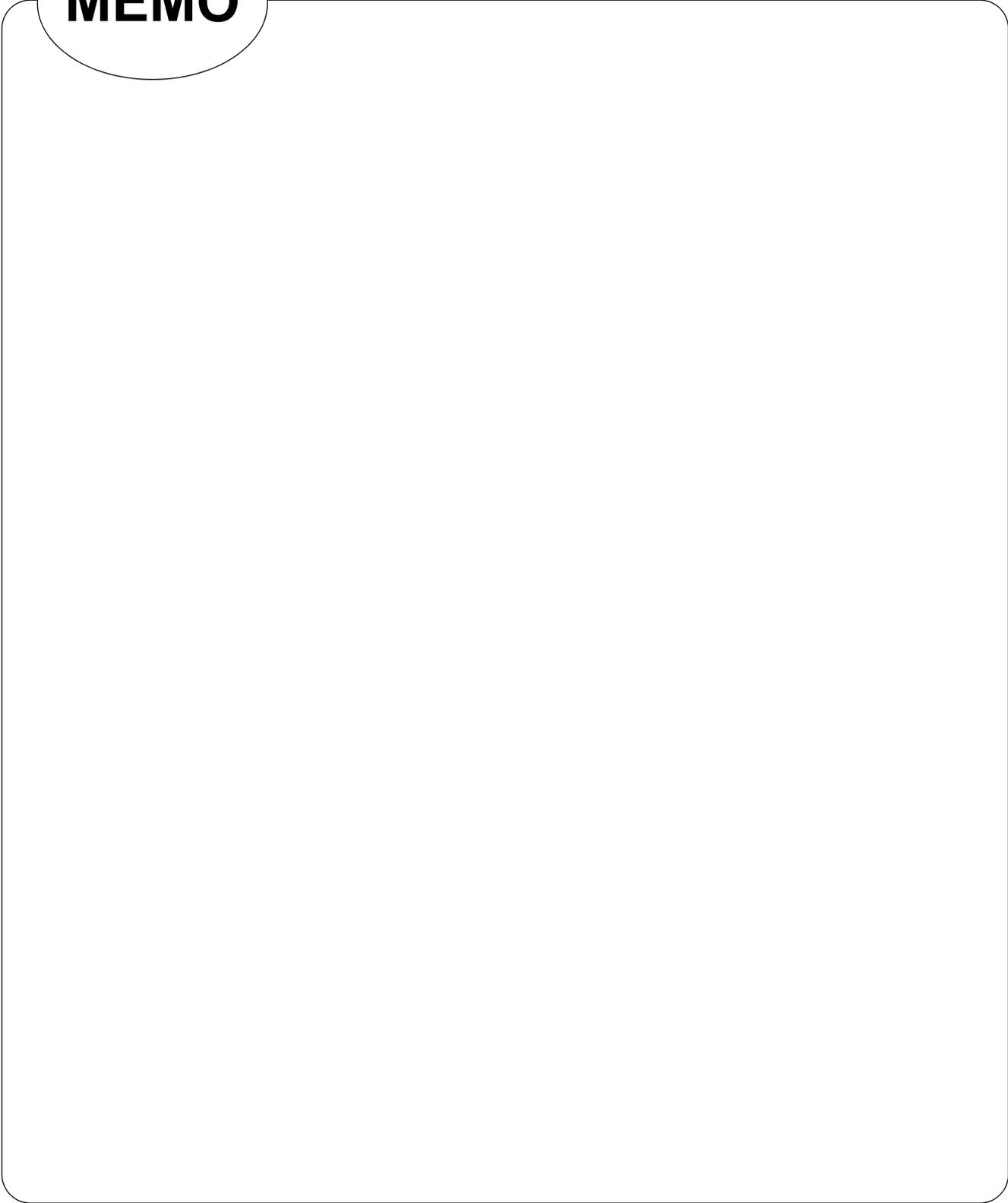
Please confirm the latest Package dimension by following URL.
<http://edevice.fujitsu.com/package/en-search/>

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